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### DS90UH940-Q1

SNLS478A-NOVEMBER 2014-REVISED JANUARY 2016

# DS90UH940-Q1 1080p FPD-Link III to CSI-2 Deserializer with HDCP

Technical

Documents

## 1 Features

- Supports Pixel Clock Frequency up to 170 MHz for WUXGA (1920x1200) and 1080p60 Resolutions with 24-bit Color Depth
- 1-lane or 2-lane FPD-Link III Interface with Deskew Capability
- MIPI D-PHY / CSI-2 Transmitter
  - CSI-2 Output Ports with selectable 2- or 4-lane operation
  - Supports up to 4 Data Lanes per CSI-2 port, Each Lane up to 1.3 Gbps
  - Video formats: RGB888/666/565, YUV422/420, RAW8/10/12
  - Programmable Virtual Channel Identifier
- Integrated HDCP cipher engine with on-chip key storage
- High Speed GPIO up to 2.0 Mbps
- Supports up to 15 meters of cable with automatic temperature and aging compensation
- SPI Control Interfaces up to 3.3 Mbps
- I<sup>2</sup>C (Master/Slave) with 1 Mbps Fast-mode Plus
- Adaptive Receive Equalization
- Supports 7.1 Multiple I2S (4 data) Channels
- Backward Compatible to DS90UH925/925AQ-Q1 and DS90UH927Q-Q1 FPD-Link III Serializers
- Automotive Grade Product: AEC-Q100 Grade 2
   Qualified

# 2 Applications

- Automotive Infotainment:
  - Central Information Displays
  - Rear Seat Entertainment Systems
  - Digital Instrument Clusters
- ADAS Camera Systems

# 4 Applications Diagram

# 3 Description

Tools &

Software

The DS90UH940-Q1 is a FPD-Link III Deserializer which, in conjunction with the DS90UH949/947/929-Q1 Serializers, converts 1-lane or 2-lane FPD-Link III streams into a MIPI CSI-2 interface. The Deserializer is capable of operating over cost-effective  $50\Omega$  single-ended coaxial or  $100\Omega$  differential shielded twisted-pair (STP) cables. It recovers the data from one or two FPD-Link III serial streams and translates it into a Camera Serial Interface (CSI-2) format supporting video resolutions up to WUXGA and 1080p60 with 24-bit color depth.

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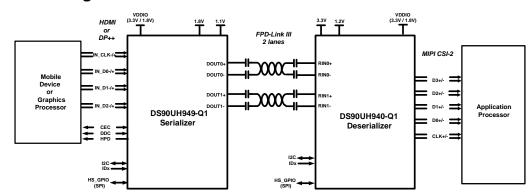
The FPD-Link III interface supports video and audio data transmission and full duplex control, including I<sup>2</sup>C and SPI communication, over the same differential link. Consolidation of video data and control over two differential pairs reduces the interconnect size and weight and simplifies system design. EMI is minimized by the use of low voltage differential signaling, data scrambling, and randomization. In backward compatible mode, the device supports up to WXGA and 720p resolutions with 24-bit color depth over a single differential link.

The device automatically detects the FPD-Link III channels and provides a clock alignment and deskew functionality without the need for any special training patterns. This ensures skew phase tolerance from mismatches in interconnect wires such as PCB trace routing, cable pair-to-pair length differences, and connector imbalances.

#### Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
DS90UH940-Q1	WQFN NKD (64)	9.00 mm x 9.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.





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# 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Original (November 2014) to Revision A

### Page

•	Added shared pins description on SPI pins	5
•	Added shared pins description on GPIO pins	6
•	Added shared pins description on D_GPIO pins	6
•	Added shared pins description on register only GPIO pins. Changed "Local register control only" to "I2C register control only".	6
•	Added shared pins description on slave mode I2S pins	
•	Added shared pins description on master mode I2S pins	
•	Added legend on I/O TYPE	
•	Moved Storage Temperature Range from ESD to Absolute Maximum Ratings table	9
•	Added ESD Ratings table	9
•	Changed IDD12Z limit from 11mA to 30mA per PE re-characterization	. 12
•	Changed Fast Plus Mode t <sub>sP</sub> maximum from 20ns to 50ns	. 14
•	Added Power Sequence section	. 22
•	Deleted MODE, CSI LANE, REPLICATE columns in MODE_SEL0 table	. 40
•	Deleted MODE column. Added (CSI PORT) to CSI_SEL column in MODE_SEL1 table	. 40
•	Changed default value from "0" to "1" in register 0x01[2]	. 47
•	Added description to register 0x01[1] "Registers which are loaded by pin strap will be restored to their original strap value when this bit is set. These registers show 'Strap' as their default value in this table."	. 47
•	Added to 0x02[7] in Description column "A Digital reset 0x01[0] should be asserted after toggling Output Enable bit LOW to HIGH"	. 47
•	Added "Loaded from remote SER" in register 0x07[7:1] function column	. 49
•	Changed signal detect bit to reserved in register 0x1C[1]	. 52
•	Changed "0" to "0/1" in register RW column of 0x1C[1]	. 52

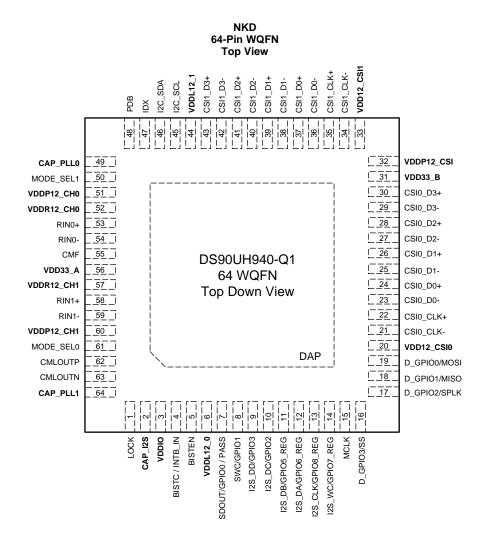


# **Revision History (continued)**

•	Changed signal detect bit to reserved in register 0x1C[1] description	52
•	Changed from Reserved to Rev-ID in register 0x1D Function column	53
•	On register 0x22 added "(Loaded from remote SER)"	56
•	Corrected in register 0x24[3] 0: Bist configured through "bit 0" to "bits 2:0" in description	58
•	Added in register 0x24[2:1] additional description	58
•	Changed in register 0x24[1] description to "internal"	58
•	Changed in register 0x24[2] description to "internal"	58
•	On register 0x28 added "Loaded from remote SER"	59
•	Added clarification description on register 0x37 MODE_SEL	61
•	Merged on 0x45 bits[7:4} and bits[3:0] default value: 0x08	62



# 6 Pin Configurations and Functions



#### **Pin Functions**

PIN		I/O, TYPE	DESCRIPTION		
NAME	NUMBER	VO, TIPE	DESCRIPTION		
MIPI DPHY / CSI-2 C pulldown)	OUTPUT PINS	S - Layout note:	for unused CSI outputs, float those pins (do not connect to an external pullup or		
CSI0_CLK- CSI0_CLK+	21 22	O, DPHY	CSI0 Differential clock		
CSI0_D0- CSI0_D0+	23 24	O, DPHY	CSI0 Differential pair 0		
CSI0_D1- CSI0_D1+	25 26	O, DPHY	CSI0 Differential pair 1		
CSI0_D2- CSI0_D2+	27 28	O, DPHY	CSI0 Differential pair 2		
CSI0_D3- CSI0_D3+	29 30	O, DPHY	CSI0 Differential pair 3		
CSI1_CLK- CSI1_CLK+	34 35	O, DPHY	CSI1 Differential clock		
CSI1_D0- CSI1_D0+	36 37	O, DPHY	CSI1 Differential pair 1		
CSI1_D1- CSI1_D1+	38 39	O, DPHY	CSI1 Differential pair 2		

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# Pin Functions (continued)

PIN			
NAME	NUMBER	I/O, TYPE	DESCRIPTION
CSI1_D2- CSI1_D2+	40 41	O, DPHY	CSI1 Differential pair 3
CSI1_D3- CSI1_D3+	42 43	O, DPHY	CSI1 Differential pair 3
FPD-LINK III INTE pulldown)	RFACE - Layo	ut note: for unu	sed FPD-LinkIII inputs, float those pins (do not connect to an external pullup or
RIN0-	54	I/O, CML	FPD-Link III Inverting Input/Output The output must be AC-coupled with a 33 nF capacitor.
RIN0+	53	I/O, CML	FPD-Link III True Input/Output The output must be AC-coupled with a 33 nF capacitor.
RIN1-	59	I/O, CML	FPD-Link III Inverting Input/Output The output must be AC-coupled with a 33 nF capacitor.
RIN1+	58	I/O, CML	FPD-Link III True Input/Output The output must be AC-coupled with a 33 nF capacitor.
CMF	55	I/O, CML	Common Mode Filter. Connect 0.1 µF capacitor to GND
I2C PINS			
I2C_SDA	46	I/O, Open- Drain	I2C Data Input / Output interface Open drain. Must have an external pull-up resistor to VDDIO <b>DO NOT FLOAT.</b> Recommended pull-up: $4.7 \text{ k}\Omega$ .
I2C_SCL	45	I/O, Open- Drain	I2C Clock Input / Output Interface Open drain. Must have an external pull-up resistor to VDDIO DO NOT FLOAT. Recommended pull-up: 4.7 k $\Omega$ .
IDx	47	I, Analog Configuration Pin	Analog input. I2C Serial Control Bus Device ID Address. Table 11
SPI PINS (Pin fund	ction program	med through re	gister) - Layout note: for unused SPI pins, tie to an external pulldown
MOSI (D_GPIO0)	19	Multi-function pin I/O, LVCMOS w/ weak internal PD	Master Out, Slave In. (Pin is shared with D_GPIO0)
MISO (D_GPIO1)	18	Multi-function pin I/O, LVCMOS w/ weak internal PD	Master In, Slave Out. (Pin is shared with D_GPIO1)
SPLK (D_GPIO2)	17	Multi-function pin I/O, LVCMOS w/ weak internal PD	Serial clock. (Pin is shared with D_GPIO2)
SS (D_GPIO3)	16	Multi-function pin I/O, LVCMOS w/ weak internal PD	Slave select. (Pin is shared with D_GPIO3)
CONTROL PINS			
MODE_SEL0	61	I, Analog Configuration Pin	Analog input. Mode Select 0. Connect to external pull-up to VDD33 and pull-down to GND to create a voltage divider. See Table 8
MODE_SEL1	50	I, Analog Configuration Pin	Analog input. Mode Select 1. Connect to external pull-up to VDD33 and pull-down to GND to create a voltage divider. See Table 9

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# Pin Functions (continued)

PIN			
NAME	NUMBER	I/O, TYPE	DESCRIPTION
PDB	48	I, LVCMOS Configuration Pin w/ weak internal PD	Power-Down Mode Input Pin PDB = 1, device is enabled (normal operation) PDB = 0, device is powered down. When the device is in the POWER DOWN state, the LVCMOS outputs are in tri-state, the PLL is shutdown and IDD is minimized. Note: PDB pin requires minimum ramp time of 200us
BISTEN	5	I, LVCMOS Configuration Pin w/ weak internal PD	Bist Enable Pin 0: BIST Mode is disabled. 1: BIST Mode is enabled. See Built-In Self Test (BIST) for more information
BISTC (INTB_IN)	4	I, LVCMOS Configuration Pin w/ weak internal PD	Bist Clock Select. 0: PCLK 1: 33MHz (Pin is shared with INTB_IN)
INTB_IN (BISTC)	4	I, LVCMOS w/ weak internal PD	Interrupt input. (Pin is shared with BISTC)
BIDIRECTIONAL CO	NTROL CHA	ANNEL (BCC) G	PIO PINS (default pin function) - Layout note: for unused GPIO(s), tie to an external
GPIO0 (SDOUT)	7	Multi-function pin I/O, LVCMOS	BCC GPIO0. default state: logic <i>LOW</i> (Pin is shared with SDOUT)
GPIO1 (SWC)	8	Multi-function pin I/O, LVCMOS	BCC GPIO1. default state: logic <i>LOW</i> (Pin is shared with SWC)
GPIO2 (I2S_DC)	10	Multi-function pin I/O, LVCMOS	BCC GPIO2. default state: logic <i>LOW</i> (Pin is shared with I2S_DC)
GPIO3 (I2S_DD)	9	Multi-function pin I/O, LVCMOS	BCC GPIO3. default state: logic <i>LOW</i> (Pin is shared with I2S_DD)
HIGH-SPEED GPIO	PINS HIGH-S	SPEED GPIO PI	NS (default pin function) - Layout note: for unused D_GPIO(s), tie to an external
D_GPIO0 (MOSI)	19	I/O, LVCMOS	General Purpose I/O in 2-lane FPD-Link III mode default state: <i>tri-state</i> (Pin is shared with MOSI)
D_GPIO1 (MISO)	18	I/O, LVCMOS	General Purpose I/O in 2-lane FPD-Link III mode default state: <i>tri-state</i> (Pin is shared with MISO)
D_GPIO2 (SPLK)	17	I/O, LVCMOS	General Purpose I/O in 2-lane FPD-Link III mode default state: <i>tri-state</i> (Pin is shared with SPLK)
D_GPIO3 (SS)	16	I/O, LVCMOS	General Purpose I/O in 2-lane FPD-Link III mode default state: <i>tri-state</i> (Pin is shared with SS)
REGISTER READ/W		( GPIO PINS (de	fault pin function) - Layout note: for unused GPIO(s), tie to an external pulldown
GPIO5_REG (I2S_DB)	11	Multi-function pin I/O, LVCMOS	General Purpose Input/Output 5 I2C register control only. default state: logic <i>LOW</i> (Pin is shared with I2S_DB)
GPIO6_REG (I2S_DA)	12	Multi-function pin I/O, LVCMOS	General Purpose Input/Output 6 I2C register control only. default state: logic <i>LOW</i> (Pin is shared with I2S_DA)



### **Pin Functions (continued)**

PIN			
NAME	NUMBER	I/O, TYPE	DESCRIPTION
GPIO7_REG (I2S_WC)	14	Multi-function pin I/O, LVCMOS	General Purpose Input/Output 7 I2C register control only. default state: logic <i>LOW</i> (Pin is shared with I2S_WC)
GPIO8_REG (I2S_CLK)	13	Multi-function pin I/O, LVCMOS	General Purpose Input/Output 8 I2C register control only. default state: logic <i>LOW</i> (Pin is shared with I2S_CLK)
SLAVE MODE LOC		INEL PINS (Pin	function programmed through register) - Layout note: for unused I2S outputs, tie
I2S_WC (GPIO7_REG)	14	Multi-function pin O, LVCMOS	Slave Mode I2S Word Clock Output. (Pin is shared with GPIO7_REG)
I2S_CLK (GPIO8_REG)	13	Multi-function pin O, LVCMOS	Slave Mode I2S Clock Output. (Pin is shared with GPI08_REG)
I2S_DA (GPIO6_REG)	12	Multi-function pin O, LVCMOS	Slave Mode I2S Data Output. (Pin is shared with GPIO6_REG)
I2S_DB (GPIO5_REG)	11	Multi-function pin O, LVCMOS	Slave Mode I2S Data Output. (Pin is shared with GPIO5_REG)
I2S_DC (GPIO2_REG)	10	Multi-function pin O, LVCMOS	Slave Mode I2S Data Output. (Pin is shared with GPIO2)
I2S_DD (GPIO3_REG)	9	Multi-function pin O, LVCMOS	Slave Mode I2S Data Output. (Pin is shared with GPIO3)
MASTER MODE LO an external pulldow		ANNEL PINS (Pi	n function programmed through register) - Layout note: for unused GPIO(s), tie to
SWC (GPIO1)	8	Multi-function pin O, LVCMOS	Master Mode I2S Word Clock Output. (Pin is shared with GPIO1)
SDOUT (GPIO0)	7	Multi-function pin O, LVCMOS	Master Mode I2S Data Output. (Pin is shared with GPIO0)
MCLK (GPIO9)	15	Multi-function pin O, LVCMOS	Master Mode I2S System Clock Output. (Pin is shared with GPIO9)
STATUS PINS - Lay	out note: ad	d a test point (1	TP) on these pins
PASS	7	O, LVCMOS	<ul> <li>Normal mode status output pin (BISTEN = 0)</li> <li>PASS = 1: No fault detected on input display timing</li> <li>PASS = 0: Indicates an error condition or corruption in display timing. Fault condition occurs:</li> <li>1. DE length value mismatch measured once in succession</li> <li>2. VSync length value mismatch measured twice in succession</li> </ul>
			BIST mode status output pin (BISTEN = 1) PASS = 1: No error detected PASS = 0: Error detected
POWER & GROUNE	<b>)</b> <sup>(1)</sup>		
VDD33_A, VDD33_B	56 31	Power	3.3V (±10%) supply. Power to on-chip regulator. Requires 10 $\mu F,$ 1 $\mu F,$ 0.1 $\mu F,$ and 0.01 $\mu F$ capacitors to GND
VDDIO	3	Power	LVCMOS I/O power supply, 1.8V (±5%) OR 3.3V (±10%). Requires 10 $\mu F,$ 1 $\mu F,$ 0.1 $\mu F,$ and 0.01 $\mu F$ capacitors to GND

(1) The VDD (VDD12, VDD33, and VDDIO) supply ramp should be faster than 1.5ms with a monotonic rise

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### Pin Functions (continued)

PIN			DECODIDITION	
NAME	NUMBER	I/O, TYPE	DESCRIPTION	
VDD12_CSI0 VDDP12_CSI VDD12_CSI1 VDD12_O VDDL12_1 VDDP12_CH0 VDDR12_CH0 VDDP12_CH0 VDDP12_CH1	20 32 33 6 44 51 52 60	Power	1.2V (±5%) supplies. Requires 10 $\mu F,$ 1 $\mu F,$ 0.1 $\mu F,$ and 0.01 $\mu F$ capacitors to GND at each VDD pin.	
VDDR12_CH1 CAP_PLL0 CAP_PLL1 CAP_I2S	57 49 64 2	CAP	Decoupling capacitor connection for on-chip regulator. Each requires a 0.1 $\mu\text{F}$ decoupling capacitor to GND.	
VSS DAP		Ground	DAP is the large metal contact at the bottom side, located at the center of the WQFN package. Connect to the ground plane (GND) with at least 32 vias.	
OTHER PINS				
CMLOUTP CMLOUTN	62 63	O, CML	Monitor point for equalized differential signal. Layout recommendation: 1) place 0.1 µF series capacitor on CMLOUTP and CMLOUTN 2) place 100ohm termination between 0.1 µF away from CMLOUTP and CMLOUTN pins 3) place test points from 0.1 µF capacitors	

The definitions below define the functionality of the I/O cells for each pin.

I/O TYPE:

- P = Power Supply
- G = Ground
- CML = CML Interface
- DPHY = MIPI DPHY Interface
- Analog = Analog Interface
- LVCMOS = LVCMOS pin; Referenced to VDDIO IO supply
- I = Input
- O = Output
- I/O = Input/Output
- PD, PU = Internal Pull-Down/Pull-Up (All strap pins have weak internal pull-ups or pull-downs. If the default strap value is needed to be changed then an external resistor should be used.)
- Multi-function pin

8



# 7 Specifications

# 7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)<sup>(1) (2)</sup>

	PARAMETER	MIN	MAX	UNIT
VDD33	Supply voltage	-0.3	4.0	V
VDD12	Supply voltage	-0.3	1.8	V
VDDIO	Supply voltage	-0.3	4.0	V
	LVCMOS I/O voltage	-0.3	VDDIO + 0.3	V
	FPD-Link III input voltage	-0.3	2.75	V
TJ	Junction temperature		150	°C
T <sub>stg</sub>	Storage temperature range	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) For soldering specifications, see product folder at www.ti.com and SNOA549

# 7.2 ESD Ratings—JEDEC

			VALUE	UNIT
V	Flastrastatia disabarga	Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup>	±8000	M
V <sub>(ESD)</sub>	Electrostatic discharge	Charged-device model (CDM), per AEC Q100-011	±1250	v

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

## 7.3 ESD Ratings—IEC and ISO

				VALUE	UNIT
		R <sub>D</sub> = 330 Ω, C <sub>S</sub> = 150 pF	IEC, powered-up only contact discharge $(R_{IN0+}, R_{IN0-}, R_{IN1+}, R_{IN1-})$	±8000	V
		IEC, powered-up only air-gap discharge (RIN0+, RIN0-, RIN1+, RIN1-)	±15000	v	
V	Electrostatic discharge	$R_{\rm D} = 330 \ \Omega, C_{\rm S} = 150 \text{ and } 330 \text{ pF}$	ISO10605 contact discharge ( $R_{IN0+}, R_{IN0-}, R_{IN1+}, R_{IN1-}$ )	±8000	V
V <sub>(ESD)</sub>	Electrostatic discharge	$R_{\rm D} = 350.22, C_{\rm S} = 150$ and 350 pr	ISO10605 air-gap discharge ( $R_{IN0+}, R_{IN0-}, R_{IN1+}, R_{IN1-}$ )	±15000	v
			ISO10605 contact discharge ( $R_{IN0+}, R_{IN0-}, R_{IN1+}, R_{IN1-}$ )	±8000	V
		$R_D = 2 k\Omega$ , $C_S = 150$ and 330 pF	ISO10605 air-gap discharge ( $R_{IN0+}, R_{IN0-}, R_{IN1+}, R_{IN1-}$ )	±15000	V

### 7.4 Recommended Operating Conditions

	MIN	NOM	MAX	UNIT
Supply Voltage (VDD33)	3.0	3.3	3.6	V
Supply Voltage (VDD18)	1.71	1.8	1.89	V
Supply Voltage (VDD12)	1.14	1.2	1.26	V
Operating Free Air Temperature (T <sub>A</sub> )	-40	25	105	°C
Pixel Clock Frequency (Single Link)	25		96	MHz
Pixel Clock Frequency (Dual Link)	50		170	MHz
Supply Noise VDD33 (DC-50MHz)			100	mV <sub>P-P</sub>
Supply Noise VDD18 (DC-50MHz)			50	mV <sub>P-P</sub>
Supply Noise VDD12 (DC-50MHz)			25	mV <sub>P-P</sub>

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## 7.5 Thermal Information

		DS90UH940-Q1	
	THERMAL METRIC <sup>(1)</sup>	WQFN (NKD)	UNIT
		64 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	24.8	
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	6.2	
$R_{\theta JB}$	Junction-to-board thermal resistance	3.6	°C/W
ΨJT	Junction-to-top characterization parameter	0.1	C/W
Ψјв	Junction-to-board characterization parameter	3.6	
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	0.6	

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

# 7.6 DC Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

	1 0 11 7						
	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN	TYP	MAX	UNIT
3.3V LV0	CMOS I/O (VDDIO = 3.3V ± 10%)						
VIH	High Level Input Voltage		PDB, BISTEN,	2.0		VDDIO	V
V <sub>IL</sub>	Low Level Input Voltage		BISTC, GPIO[3:0],	0		0.8	V
I <sub>IN</sub>	Input Current	V <sub>IN</sub> = 0V or VDDIO	D_GPIO[3:0],	-10		10	μA
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -4mA	I2S_DA, I2S_DB,	2.4		VDDIO	V
V <sub>OL</sub>	Low Level Output Voltage	$I_{OL} = +4mA$	12S_DC,	0		0.4	V
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> = 0V	I2S_DD,		-55		mA
I <sub>OZ</sub>	Tri-state Output Current	PDB = 0V V <sub>OUT</sub> = 0V or VDDIO	I2S_CLK, I2S_WC, LOCK, PASS	-20		20	μA
C <sub>IN</sub>	Input Capacitance					10	pF
1.8V LV0	CMOS I/O (VDDIO = 1.8V ± 5%)						
V <sub>IH</sub>	High Level Input Voltage		PDB, BISTEN, BISTC,	0.65 * VDDIO		VDDIO	V
V <sub>IL</sub>	Low Level Input Voltage		GPIO[3:0], D_GPIO[3:0], I2S_DA,	0		0.35 * VDDIO	V
I <sub>IN</sub>	Input Current	V <sub>IN</sub> = 0V or VDDIO	I2S_DB,	-10		10	μA
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -4mA	I2S_DC, I2S_DD, I2S_CLK,	VDDIO- 0.45		VDDIO	V
V <sub>OL</sub>	Low Level Output Voltage	$I_{OL} = +4mA$	125_0LK, 12S_WC,	0		0.45	V
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> = 0V	LOCK, PASS		-35		mA
I <sub>OZ</sub>	Tri-state Output Current	PDB = 0V V <sub>OUT</sub> = 0V or VDDIO		-20		20	μA
C <sub>IN</sub>	Input Capacitance					10	pF
SERIAL	CONTROL BUS (VDDIO = 1.8V ± 5	% OR 3.3V ± 10%)					
V <sub>IH</sub>	Input High Level		I2C_SDA, I2C_SCL	0.7 * VDDIO		VDD33	V
V <sub>IL</sub>	Input Low Level			GND		0.3 * VDDIO	V
$V_{HY}$	Input Hysteresis				>50		mV
V <sub>OL</sub>	Output Low Level	$I_{OL} = +4mA$		0		0.4	V
I <sub>IN</sub>	Input Current	V <sub>IN</sub> = 0V or VDDIO		-10		10	μA
-							



# **DC Electrical Characteristics (continued)**

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN	TYP	MAX	UNIT
FPD-LINK III	CML INPUT						
V <sub>TH</sub>	Differential Threshold High Voltage	$V_{CM}$ = 2.1V (Internal V <sub>BIAS</sub> )	RIN0+, RIN0- RIN1+, RIN1-			50	mV
V <sub>TL</sub>	Differential Threshold Low Voltage			-50			mV
V <sub>ID</sub>	Input Differential Threshold			100			mV
V <sub>CM</sub>	Differential Common-mode Voltage				2.1		V
R <sub>T</sub>	Internal Termination Resistor - Differential			80	100	120	Ω
HSTX DRIVE	ĒR						
V <sub>CMTX</sub>	HS transmit static common-mode voltage		CSI0_D3±, CSI0_D2±,	150	200	250	mV
$ \Delta V_{CMTX(1,0)} $	V <sub>CMTX</sub> mismatch when output is 1 or 0		CSI0_D1±, CSI0_D0±, CSI0_CLK±,			5	mV <sub>P-P</sub>
V <sub>OD</sub>	HS transmit differential voltage		CSI1_D3±,	140	200	270	mV
$ \Delta V_{OD} $	V <sub>OD</sub> mismatch when output is 1 or 0		CSI1_D2±, CSI1_D1±,			14	mV
V <sub>OHHS</sub>	HS output high voltage		– CSI1_D0±,   CSI1_CLK±			360	mV
Z <sub>OS</sub>	Single-ended output impedance			40	50	62.5	Ω
$\Delta Z_{OS}$	Mismatch in single-ended output impedance					10	%
LPTX DRIVE	R					1	
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -4mA	CSI0_D3±,	1.05	1.2	1.3	V
V <sub>OL</sub>	Low Level Output Voltage	$I_{OL} = +4mA$	CSI0_D2±, CSI0_D1±,	-50		50	mV
Z <sub>OLP</sub>	Output impedance		CSI0_D0±, CSI0_CLK±, CSI1_D3±, CSI1_D2±, CSI1_D1±, CSI1_D0±, CSI1_CLK±	110			Ω
LOOP-THRC	UGH MONITOR OUTPUT					1	
V <sub>ODp-p</sub>	Differential Output Voltage	R <sub>L</sub> = 100Ω	CMLOUTP, CMLOUTN		360		mV
SUPPLY CU	RRENT	•	+				
P <sub>T</sub>	Total Power Consumption, Normal Operation	Checkerboard Pattern, 170MHz. See Figure 1. 2-lane FPD-Link III Input, 2 MIPI lanes Output	VDD		628	875	mW
Pz	Total Power Consumption, Power-Down Mode	PDB = 0V			10	45	mW
IDD12	Supply Current, Normal	Checkerboard Pattern, 96MHz.	VDD12 = 1.2 V		150	250	mA
IDD33	Operation	See Figure 1. 1-lane FPD-Link III Input, 2	VDD33 = 3.6 V		90	122	mA
IDDIO		MIPI lanes Output	VDDIO = 1.89 V		1	6	mA
			VDDIO = 3.6 V		1	6	mA
IDD12	Supply Current, Normal	Checkerboard Pattern, 96MHz.	VDD12 = 1.2 V		125	225	mA
IDD33	Operation	See Figure 1. 1-lane FPD-Link III Input, 4	VDD33 = 3.6 V		90	122	mA
IDDIO		MIPI lanes Output	VDDIO = 1.89 V		1	6	mA
			VDDIO = 3.6 V		1	6	mA

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# **DC Electrical Characteristics (continued)**

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN TY	P MAX	UNIT
IDD12	Supply Current, Normal	Checkerboard Pattern,	VDD12 = 1.2 V	25	0 345	mA
IDD33	Operation	Operation 170MHz. See Figure 1. 2-lane FPD-Link III Input, 2	VDD33 = 3.6 V	g	0 122	mA
IDDIO		MIPI lanes Output	VDDIO = 1.89 V		1 6	mA
			VDDIO = 3.6 V		1 6	mA
IDD12	Supply Current, Normal	Checkerboard Pattern,	VDD12 = 1.2 V	22	0 300	mA
IDD33	Operation	170MHz. See Figure 1. 2-lane FPD-Link III Input, 4	VDD33 = 3.6 V	ę	0 122	mA
IDDIO		MIPI lanes Output	VDDIO = 1.89 V		1 6	mA
			VDDIO = 3.6 V		1 6	mA
IDD12Z	Supply Current, Power Down	PDB = 0 V	VDD12 = 1.2 V		2 30	mA
IDD33Z	Mode		VDD33 = 3.6 V		2 8	mA
IDDIOZ	Z		VDDIO = 1.89 V	0	1 0.3	mA
			VDDIO = 3.6 V	0	1 0.3	mA



### 7.7 AC Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN TYP	MAX	UNIT
GPIO BIT	RATE	1		I		
R <sub>b,FC</sub>	Forward Channel Bit Rate	PCLK = 25MHz - 170MHz <sup>(1)</sup>	GPIO[3:0]	0.25 * PCLK		Mbps
R <sub>b,BC</sub>	Back Channel Bit Rate			133		kbps
R <sub>b,BC</sub>	Back Channel Bit Rate	High Speed (2-lane Mode), 1 D_GPIO active. See Table 4.	D_GPIO[3:0]	2.0		Mbps
		High Speed (2-lane Mode), 2 D_GPIO's active. See Table 4.		1.33		Mbps
		High Speed (2-lane Mode), 4 D_GPIO's active. See Table 4.		800		kbps
		Normal mode. See Table 4.		133		kbps
t <sub>GPIO,FC</sub>	GPIO Pulse Width, Forward Channel		GPIO[3:0]	>2 / PCLK <sup>(1)</sup>		S
t <sub>GPIO,BC</sub>	GPIO Pulse Width, Back Channel		GPIO[3:0]	20		μs
RESET				L	1	
t <sub>LRST</sub>	PDB Reset Low Pulse		PDB	2		ms
LOOP-TH	ROUGH MONITOR OUTPUT					
Ew	Differential Output Eye Opening Width	RL = $100\Omega$ , Jitter frequency > PCLK <sup>(1)</sup> / 40	CMLOUTP, CMLOUTN	0.4		UI
E <sub>H</sub>	Differential Output Eye Height	See Figure 2.		>300		mV
FPD-LINK						
t <sub>DDLT</sub>	Lock Time	See Figure 4.	RIN0+, RIN0-, RIN1+, RIN1-	5	10 <sup>(2)</sup>	ms
I2S TRAN	ISMITTER					
t <sub>J,I2S</sub>	Clock Output Jitter		I2S_CLK	2		ns
t <sub>I2S</sub>	I2S Clock Period <sup>(3)</sup>	See Figure 9.		>2 / PCLK <sup>(1)</sup> or >77		ns
t <sub>HC,I2S</sub>	I2S Clock High Time <sup>(3)</sup>	See Figure 9.		0.48		t <sub>I2S</sub>
t <sub>LC,I2S</sub>	I2S Clock Low Time <sup>(3)</sup>	See Figure 9.		0.48		t <sub>I2S</sub>
t <sub>SR,I2S</sub>	I2S Set-up Time	See Figure 9.	I2S_DA,	0.4		t <sub>I2S</sub>
t <sub>HR,I2S</sub>	I2S Hold Time	See Figure 9.	I2S_DB, I2S_DC, I2S_DD	0.4		t <sub>I2S</sub>

PCLK refers to the equivalent pixel clock frequency, which is equal to the FPD-Link III line rate / 35.
 This parameter is specified by characterization and is not tested in production.
 I2S specifications for t<sub>LC,I2S</sub> and t<sub>HC,I2S</sub> pulses must each be greater than 1 PCLK period to ensure sampling and supersedes the 0.35\*t<sub>I2S</sub> requirement. t<sub>LC,I2S</sub> and t<sub>HC,I2S</sub> must be longer than the greater of either 0.35\*t<sub>I2S</sub> or 2 \* PCLK.

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# 7.8 Timing Requirements for the Serial Control Bus

Over I<sup>2</sup>C supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	MIN TYP MAX	UNIT
f <sub>SCL</sub>	SCL Clock Frequency	Standard Mode	>0 100	kHz
		Fast Mode	>0 400	kHz
		Fast Plus Mode	>0	MHz
t <sub>LOW</sub>	SCL Low Period	Standard Mode	4.7	μs
		Fast Mode	1.3	μs
		Fast Plus Mode	0.5	μs
t <sub>HIGH</sub>	SCL High Period	Standard Mode	4.0	μs
		Fast Mode	0.6	μs
		Fast Plus Mode	0.26	μs
t <sub>HD;STA</sub>	Hold time for a start or a	Standard Mode	4.0	μs
·	repeated start condition Figure 8	Fast Mode	0.6	μs
		Fast Plus Mode	0.26	μs
t <sub>SU;STA</sub>	Set Up time for a start or a	Standard Mode	4.7	μs
, -	repeated start condition	Fast Mode	0.6	μs
	Figure 8	Fast Plus Mode	0.26	μs
t <sub>HD;DAT</sub>	Data Hold Time	Standard Mode	0	μs
,	Figure 8	Fast Mode	0	μs
		Fast Plus Mode	0	μs
t <sub>SU:DAT</sub>	Data Set Up Time Figure 8	Standard Mode	250	ns
00,5/11		Fast Mode	100	ns
		Fast Plus Mode	50	ns
t <sub>SU;STO</sub>	Set Up Time for STOP	Standard Mode	4.0	μs
,	Condition	Fast Mode	0.6	μs
	Figure 8	Fast Plus Mode	0.26	μs
t <sub>BUF</sub>	Bus Free Time	Standard Mode	4.7	μs
	Between STOP and START	Fast Mode	1.3	μs
	Figure 8	Fast Plus Mode	0.5	μs
t <sub>r</sub>	SCL & SDA Rise Time,	Standard Mode	1000 <sup>(1</sup>	ns
	Figure 8	Fast Mode	300 <sup>(1</sup>	ns
		Fast Plus Mode	120 <sup>(1</sup>	ns
t <sub>f</sub>	SCL & SDA Fall Time,	Standard Mode	300 <sup>(1</sup>	ns
	Figure 8	Fast mode	300 <sup>(1</sup>	
		Fast Plus Mode	120 <sup>(1</sup>	
C <sub>b</sub>	Capacitive Load for Each Bus	Standard Mode	400	рF
-	Line	Fast Mode	400	pF
		Fast Plus Mode	550	
t <sub>SP</sub>	Input Filter	Fast Mode	50	
5.		Fast Plus Mode	50	
				1

(1) Parameter is specified by bench characterization and is not tested in production.

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### 7.9 Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN	ΤΥΡ ΜΑΧ	UNIT	
HSTX DRIV	ER		1	1			
HSTX <sub>DBR</sub>	Data bit rate <sup>(1)</sup>	MIPI 2 Lanes	CSI0_D0±	350	13	44	
		MIPI 4 Lanes	CSI0_D1±	175	11	90 Mbps	
fCLK	DDR Clock frequency <sup>(1)</sup>	MIPI 2 Lanes	CSI0_D2± CSI0_D3±	175	6	72	
		MIPI 4 Lanes	CSI1_D0±	87.5	5	95 MHz	
$\Delta V_{\text{CMTX(HF)}}$	Common mode voltage variations HF <sup>(1)</sup>	Above 450MHz	CSI1_D1± CSI1_D2±	CSI1_D1±			15 mV <sub>RM</sub>
$\Delta V_{\text{CMTX(LF)}}$	Common mode voltage variations LF <sup>(1)</sup>	Between 50 and 450MHz	CSI1_D3± CSI0_CLK±			25 mV <sub>RM</sub>	
t <sub>RHS</sub>	20% to 80% Rise and Fall HS <sup>(1)</sup>	HS bit rates ≤ 1 Gbps (UI ≥ 1 ns)	CSI1_CLK±		(	.3 UI	
t <sub>FHS</sub>		HS bit rates > 1 Gbps (UI < 1 ns)	-		0.	35 UI	
		Applicable for all HS bit rates. However, to avoid excessive radiation, bit rates ≤ 1 Gbps (UI ≥ 1 ns), should not use values below 150 ps		100		ps	
SDD <sub>TX</sub>	TX differential return loss <sup>(1)</sup>	f <sub>LPMAX</sub>			-	18 dB	
		f <sub>H</sub>					
		f <sub>MAX</sub>	-			-9 dB	
LPTX DRIVE	ER						
t <sub>RLP</sub>	Rise Time LP <sup>(2) (3)</sup>	15% to 85% rise time	CSI0_D0±			25 ns	
t <sub>FLP</sub>	Fall Time LP <sup>(2) (3)</sup>	15% to 85% fall time	CSI0_D1±			25 ns	
t <sub>REOT</sub>	Rise Time Post-EoT <sup>(1) (3)</sup>	30%-85% rise time	CSI0_D2± CSI0_D3±			35 ns	
t <sub>LP-PULSE-TX</sub>	Pulse width of the LP exclusive-OR $clock^{(1)}$	First LP exclusive-OR clock pulse after Stop state or last pulse before Stop state	CSI1_D0± CSI1_D1± CSI1_D2±	40		ns	
		All other pulses	CSI1_D3±	20		ns	
t <sub>LP-PER-TX</sub>	Period of the LP exclusive-OR clock <sup>(1)</sup>		CSI0_CLK± CSI1_CLK±	90		ns	
DV/DtSR	Slew rate <sup>(2)</sup> (3)	Cload = 0pF			5	00 mV/ns	
		Cload = 5pF			3	00 mV/ns	
		Cload = 20pF			2	50 mV/ns	
		Cload = 70pF			1	50 mV/ns	
		Cload = 0 to 70pF (Falling Edge Only)		30		mV/ns	
		Cload = 0 to 70pF (Rising Edge Only)		30		mV/ns	
		Cload = 0 to 70pF (Rising Edge Only)		30 - 0.075*(V O,INST - 700)		mV/ns	
C <sub>LOAD</sub>	Load capacitance <sup>(3)</sup>			0		70 pF	

Specification is ensured by design and is not tested in production. (1)

This parameter is specified by characterization and is not tested in production.  $C_{LOAD}$  includes the low-frequency equivalent transmission line capacitance. The capacitance of TX and RX are assumed to always be <10 pF. The distributed line capacitance can be up to 50 pF for a transmission line with 2ns delay. (2) (3)

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## Switching Characteristics (continued)

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN	TYP	MAX	UNIT
DATA-CLOC	CK TIMING SPECIFICATIONS <sup>(1)</sup> (F	Figure 10)					
UI <sub>INST</sub>	UI instantaneous	fCLK = CSI-2 DDR Clock frequency	CSI0_D0± CSI0_D1±		1/(fCLK * 2)		UI
ΔUI	UI variation	UI ≥ 1ns	CSI0_D2±	-10%		10%	UI
	PCLK = 25 - 96MHz	UI < 1ns	CSI0_D3±	-5%		5%	UI
t <sub>SKEW(TX)</sub>	Data to Clock Skew (measured	Data rate ≤ 1 Gbps	CSI1_D0± CSI1_D1±	-0.15		0.15	UIINST
	at transmitter) Skew between clock and data from ideal center	Data rate > 1 Gbps	CSI1_D2± CSI1_D3± CSI0_CLK± CSI1_CLK±	-0.2		0.2	UI <sub>INST</sub>
CSI-2 TIMIN	G SPECIFICATIONS <sup>(1)</sup> (Figure 11	, Figure 12)					
t <sub>CLK-MISS</sub>	Timeout for receiver to detect absence of Clock transitions and disable the Clock Lane HS-RX		CSI0_D0± CSI0_D1± CSI0_D2±	60			ns
t <sub>CLK-POST</sub>	HS exit		CSI0_D3± CSI1_D0±	60 + 52*UI			ns
t <sub>CLK-PRE</sub>	Time HS clock shall be driver prior to any associated Data Lane beginning the transition from LP to HS mode		CSI1_D1± CSI1_D2± CSI1_D3± CSI0_CLK±	8			UI
t <sub>CLK-</sub> PREPARE	Clock Lane HS Entry		CSI1_CLK±	38		95	ns
t <sub>CLK</sub> -SETTLE	Time interval during which the HS receiver shall ignore any Clock Lane HS transitions			95		300	ns
t <sub>CLK-TERM-EN</sub>	Time-out at Clock Lane Display Module to enable HS Termination			Time for Dn to reach VTERM- EN		38	ns
t <sub>CLK-TRAIL</sub>	Time that the transmitter drives the HS-0 state after the last payload clock bit of a HS transmission burst			60			ns
t <sub>CLK-</sub> prepare + t <sub>CLK-ZERO</sub>	TCLK-PREPARE + time that the transmitter drives the HS-0 state prior to starting the Clock			300			ns
t <sub>D-TERM-EN</sub>	Time for the Data Lane receiver to enable the HS line termination			Time for Dn to reach V- TERM- EN		35 + 4*UI	ns
t <sub>EOT</sub>	Transmitted time interval from the start of $t_{HS-TRAIL}$ to the start of the LP-11 state following a HS burst	see <sup>(4)</sup>				105 + 12*UI	ns
t <sub>HS-EXIT</sub>	Time that the transmitter drives LP=11 following a HS burst			100			ns
t <sub>HS-PREPARE</sub>	Data Lane HS Entry			40 + 4*UI		85 + 6*UI	ns

(4) (a) 1280x720p60; PCLK = 74.25MHz; 4 MIPI lanes reg0x6c=0x02; reg0x6d=0x84

- (b) 1280x720p60; PCLK = 74.25MHz; 2 MIPI lanes reg0x6c=0x02; reg0x6d=0x89 (c) 640x480p60; PCLK = 25MHz; 4 MIPI lanes reg0x6c=0x02; reg0x6d=0x82 (d) 640x480p60; PCLK = 25MHz; 2 MIPI lanes reg0x6c=0x02; reg0x6d=0x83
- (e) Other video formats may require additional register configuration.

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### **Switching Characteristics (continued)**

Over recommended operating supply and temperature ranges unless otherwise specified.

	PARAMETER	TEST CONDITIONS	PIN/FREQ.	MIN	TYP I	MAX	UNIT
t <sub>HS-PREPARE</sub> + t <sub>HS-ZERO</sub>	t <sub>HS-PREPARE</sub> + time that the transmitter drives the HS-0 state prior to transmitting the Sync sequence			145 + 10*UI			ns
ths-settle	Time interval during which the HS receiver shall ignore any Data Lane HS transitions, starting from the beginning of t <sub>HS-</sub> SETTLE			85 + 6*UI		145 + 10*UI	ns
t <sub>HS-SKIP</sub>	Time interval during which the HS-RX should ignore any transitions on the Data Lane, following a HS burst. The end point of the interval is defined as the beginning of the LP-11 state following the HS burst.			40		55 + 4*Ul	ns
t <sub>HS-TRAIL</sub>	Data Lane HS Exit			60 + 4*UI			ns
t <sub>LPX</sub>	Transmitted length of LP state		-	50			ns
t <sub>WAKEUP</sub>	Recovery Time from Ultra Low Power State (ULPS)			1			ms

### 7.10 Timing Diagrams and Test Circuits

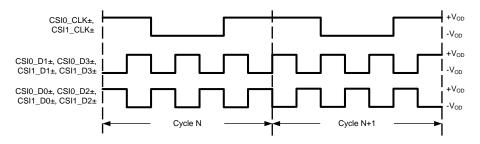


Figure 1. Checkerboard Data Pattern

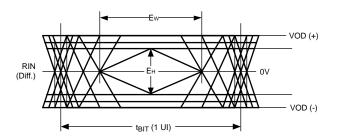


Figure 2. CML Output Driver



Figure 3. LVCMOS Transition Times

# **Timing Diagrams and Test Circuits (continued)**

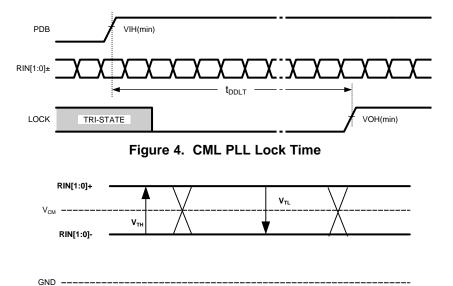


Figure 5. FPD-Link III Receiver DC V<sub>TH</sub>/V<sub>TL</sub> Definition

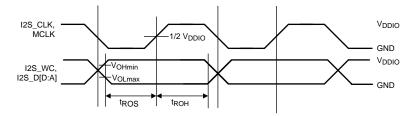
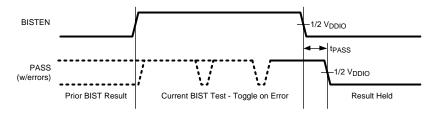
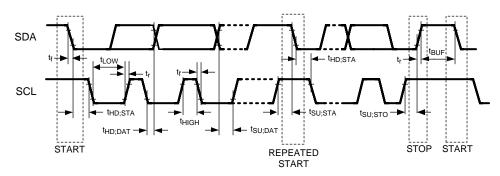


Figure 6. Output Data Valid (Setup and Hold) Times



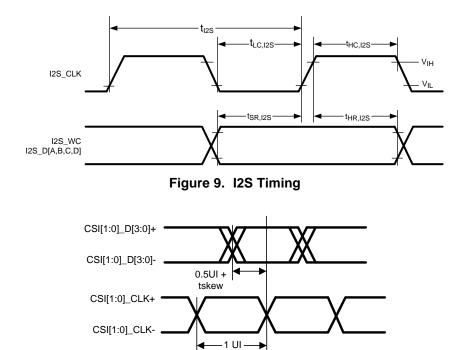
### Figure 7. BIST PASS Waveform







# **Timing Diagrams and Test Circuits (continued)**





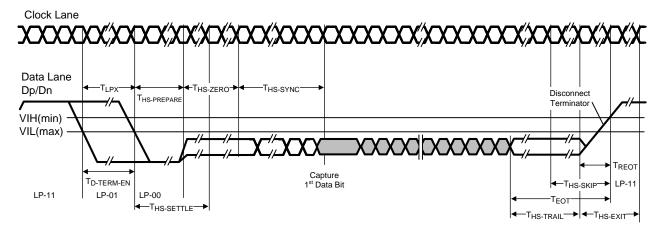


Figure 11. High Speed Data Transmission Burst



# **Timing Diagrams and Test Circuits (continued)**

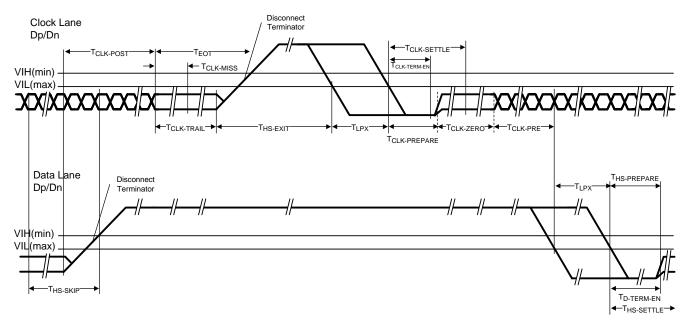


Figure 12. Switching the Clock Lane between Clock Transmission and Low-Power Mode

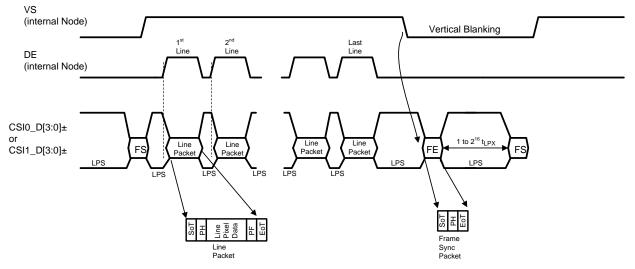


Figure 13. Long Line Packets and Short Frame Sync Packets



## **Timing Diagrams and Test Circuits (continued)**

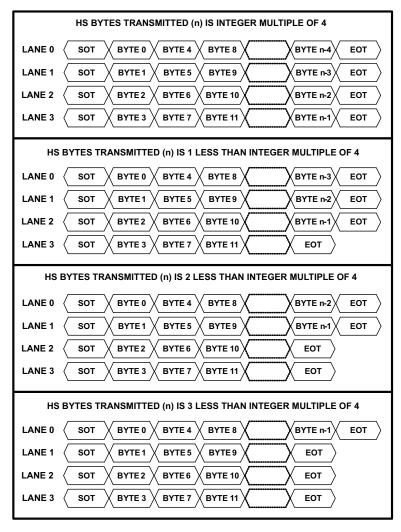


Figure 14. 4 MIPI Data Lane Configuration

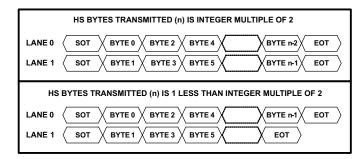


Figure 15. 2 MIPI Data Lane Configuration

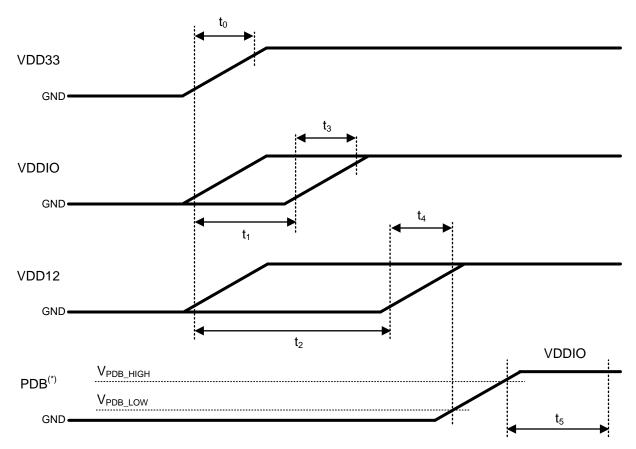
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## 7.11 Power Sequence



<sup>(\*)</sup> It is recommended to assert PDB (active High) with a microcontroller rather than an RC filter network to help ensure proper sequencing of PDB pin after settling of power supplies.

Symbol	Description	Test Conditions	Min	Тур	Max	Units
			3.0		3.6	V
VDDIO	VDDIO voltage range		1.71		1.89	V
VDD33	VDD33 voltage range		3.0		3.6	V
VDD12	VDD12 voltage range		1.14		1.26	V
	PDB LOW threshold	VDDIO = 3.3V ± 10%	0.8			
V <sub>PDB_LOW</sub>	Note: V <sub>PDB</sub> should not exceed limit for respective I/O voltage before 90% voltage of VDD12	VDDIO = 1.8V ± 5%	0.35 * VDDIO			V
	PDB HIGH threshold	VDDIO = 3.3V ± 10%			2.0	
V <sub>PDB_HIGH</sub>		VDDIO = 1.8V ± 5%			0.65 * VDDIO	V
t <sub>0</sub>	VDD33 rise time	These time constants are specified for rise time of power supply voltage ramp (10% - 90%)			<1.5	ms
t <sub>3</sub>	VDDIO rise time	These time constants are specified for rise time of power supply voltage ramp (10% - 90%)			<1.5	ms

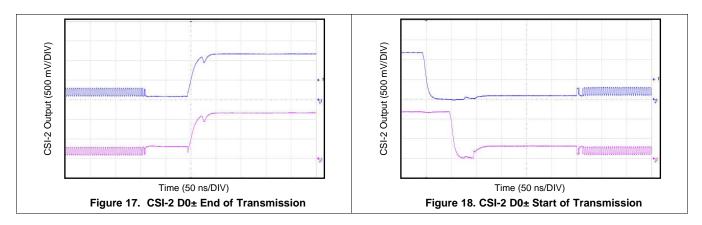


# **Power Sequence (continued)**

Symbol	Description	Test Conditions	Min	Тур	Max	Units
t <sub>4</sub>	VDD12 rise time	These time constants are specified for rise time of power supply voltage ramp (10% - 90%)			<1.5	ms
t <sub>1</sub>	VDDIO delay time	$V_{\text{IL}}$ of rising edge (VDDIO ) to $V_{\text{IL}}$ of				
t <sub>2</sub>	VDD12 delay time	rising edge (VDD_N) The power supplies may be ramped simultaneously. If sequenced, VDD33 should be first, either by itself or with VDDIO (1.8V or 3.3V) or VDD12, with the other rail(s) following in any order.	>0			ms
t <sub>5</sub>	Startup time	The part is powered up after the startup time has elapsed from the moment PDB goes HIGH. Local I2C is available to read/write 948/940 registers after this time.			<1	ms

### Table 1. Power-Up Sequencing Constraints (continued)

# 7.12 Typical Characteristics





# 8 Detailed Description

### 8.1 Overview

The DS90UH940-Q1 receives a 35-bit symbol over single or dual serial FPD-Link III pairs operating at up to 3.36 Gbps line rate in 1-lane FPD-Link III mode and 2.975 Gbps per lane in 2-lane FPD-Link III mode. The DS90UH940-Q1 converts this stream into a CSI-2 MIPI Interface (4 data channels + 1 clock, or 8 data channels + 2 clocks in replicate mode). The FPD-Link III serial stream contains an embedded clock, video control signals, audio, GPIOs, I2C, and the DC-balanced video data and audio data which enhance signal quality to support AC coupling.

The DS90UH940-Q1 is intended for use with the DS90UH949-Q1 or DS90UH947-Q1 Serializers, but is also backward compatible to the DS90UH925Q-Q1, DS90UH925AQ-Q1, and DS90UH927Q-Q1 FPD-Link III Serializers.

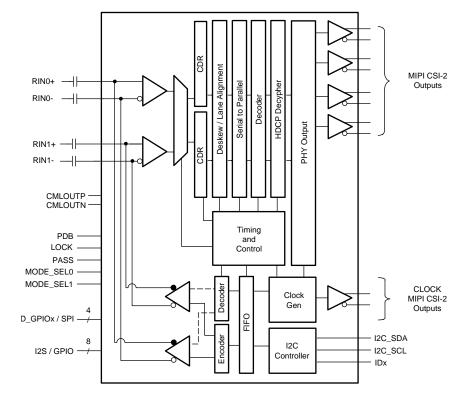
The DS90UH940-Q1 deserializer attains lock to a data stream without the use of a separate reference clock source, which greatly simplifies system complexity and overall cost. The deserializer also synchronizes to the serializer regardless of the data pattern, delivering true automatic "plug and lock" performance. It can lock to the incoming serial stream without the need of special training patterns or sync characters. The deserializer recovers the clock and data by extracting the embedded clock information, validating then deserializing the incoming data stream. It also applies decryption through a High-Bandwidth Digital Content Protection (HDCP) Cipher to this video and audio data stream following reception of the data from the FPD-Link III decoder. On-chip non-volatile memory stores the HDCP keys. All key exchange is done through the FPD-Link III bidirectional control interface. The decrypted MIPI CSI-2 interface is provided to the processor.

The DS90UH940-Q1 deserializer incorporates an I2C compatible interface. The I2C compatible interface allows programming of serializer or deserializer devices from a local host controller. In addition, the devices incorporate a bidirectional control channel (BCC) that allows communication between serializer/deserializer as well as remote I2C slave devices.

The bidirectional control channel (BCC) is implemented via embedded signaling in the high-speed forward channel (serializer to deserializer) combined with lower speed signaling in the reverse channel (deserializer to serializer). Through this interface, the BCC provides a mechanism to bridge I2C transactions across the serial link from one I2C bus to another. The implementation allows for arbitration with other I2C compatible masters at either side of the serial link.



### 8.2 Functional Block Diagram



### 8.3 Feature Description

### 8.3.1 High Speed Forward Channel Data Transfer

The High Speed Forward Channel is composed of 35 bits of data containing RGB data, sync signals, HDCP, I2C, GPIOs, and I2S audio transmitted from serializer to deserializer. Figure 19 illustrates the serial stream per clock cycle. This data payload is optimized for signal transmission over an AC coupled link. Data is randomized, balanced and scrambled.



Figure 19. FPD-Link III Serial Stream

The DS90UH940-Q1 supports clocks in the range of 25 MHz to 96 MHz over a 1-lane, or 50MHz to 170MHz over 2-lanes. The FPD-Link III serial stream rate is 3.36 Gbps maximum (875 Mbps minimum) or 2.975 Gbps maximum per lane (875 Mbps minimum) respectively.

### 8.3.2 Low Speed Back Channel Data Transfer

The Low-Speed Backward Channel provides bidirectional communication between the display and host processor. The information is carried from the deserializer to the serializer as serial frames. The back channel control data is transferred over both serial links along with the high-speed forward data, DC balance coding and embedded clock information. This architecture provides a backward path across the serial link together with a high speed forward channel. The back channel contains the I2C, HDCP, CRC and 4 bits of standard GPIO information with 5 or 20 Mbps line rate (configured by MODE\_SEL1).

### 8.3.3 FPD-Link III Port Register Access

Since the DS90UH940-Q1 contains two ports, some registers need to be duplicated to allow control and monitoring of the two ports. To facilitate this, PORT1\_SEL and PORT0\_SEL bits (0x34[1:0]) register controls access to the two sets of registers. Registers that are shared between ports (not duplicated) will be available independent of the settings in the PORT\_SEL register.



### Feature Description (continued)

Setting the PORT1\_SEL and PORT0\_SEL bit will allow a read of the register for the selected port. If both bits are set, port1 registers will be returned. Writes will occur to ports for which the select bit is set, allowing simultaneous writes to both ports if both select bits are set.

### 8.3.4 Clock and Output Status

When PDB is driven HIGH, the CDR PLL begins locking to the serial input and LOCK is tri-state or LOW (depending on the value of the OUTPUT ENABLE setting). After the deserializer completes its lock sequence to the input serial data, the LOCK output is driven HIGH, indicating valid data and clock recovered from the serial input is available on the LVCMOS and LVDS outputs. The State of the outputs is based on the OUTPUT ENABLE and OUTPUT SLEEP STATE SELECT register settings. See register 0x02 in Table 12.

	Inputs				Outputs			
Serial Input	PDB	OUTPUT ENABLE Reg 0x02 [7]	OUTPUT SLEEP STATE SELECT Reg 0x02 [4]	LOCK	PASS	Data GPIO / D_GPIO I2S	CSI-2 Output	
Х	L	Х	Х	Z	Z	Z	Z	
Х	Н	L	L	L or H	L	L	HS0	
Х	Н	L	Н	L or H	Z	Z	Z	
Static	Н	Н	L	L	L	L	HS0	
Static	н	Н	Н	L	Previous Status	L	HS0	
Active	Н	Н	L	L	L	L	HS0	
Active	Н	Н	Н	Н	Valid	Valid	Valid	

Table 2. Output State T	Table
-------------------------	-------

## 8.3.5 LVCMOS VDDIO Option

The 1.8V or 3.3V Inputs and Outputs are powered from a separate VDDIO supply to offer compatibility with external system interface signals.

#### NOTE

When configuring the VDDIO power supplies, all the single-ended data and control input pins for device need to scale together with the same operating VDDIO levels.

### 8.3.6 Power Down (PDB)

The deserializer has a PDB input pin to ENABLE or POWER DOWN the device. This pin can be controlled by the host or through the VDDIO, where VDDIO = 3. 0 V to 3.6 V or VDD33. To save power, disable the link when the display is not needed (PDB = LOW). When the pin is driven by the host, make sure to release it after VDD33 and VDDIO have reached final levels; no external components are required. In the case of driven by the VDDIO = 3.0 V to 3.6 V or VDD33 directly, a  $10 \text{k}\Omega$  resistor to the VDDIO = 3.0 V to 3.6 V or VDD33, and a >10 µF capacitor to the GND are required (see Figure 37 Typical Connection Diagram).

### 8.3.7 Interrupt Pin — Functional Description and Usage (INTB\_IN)

The INTB\_IN pin is an active low interrupt input pin. This interrupt signal, when configured, will propagate to the paired serializer. Consult the appropriate Serializer datasheet for details of how to configure this interrupt functionality.

- 1. On the Serializer, set register 0xC6[5] = 1 and 0xC6[0] = 1
- 2. Deserializer INTB\_IN (pin 4) is set *LOW* by some downstream device.
- 3. Serializer pulls INTB pin LOW. The signal is active LOW, so a LOW indicates an interrupt condition.
- 4. External controller detects INTB = LOW; to determine interrupt source, read HDCP\_ISR register.
- 5. A read to HDCP\_ISR will clear the interrupt at the Serializer, releasing INTB.
- 6. The external controller typically must then access the remote device to determine downstream interrupt source and clear the interrupt driving the Deserializer INTB\_IN. This would be when the downstream device



releases the INTB\_IN (pin 4) on the Deserializer. The system is now ready to return to step (2) at next falling edge of INTB\_IN.

### 8.3.8 General-purpose I/O

### 8.3.8.1 GPIO[3:0] and D\_GPIO[3:0] Configuration

In normal operation, GPIO[3:0] may be used as general purpose IOs in either forward channel (outputs) or back channel (inputs) mode. GPIO and D\_GPIO modes may be configured from the registers (Table 11). The same registers configure either GPIO or D\_GPIO, depending on the status of PORT1\_SEL and PORT0\_SEL bits (0x34[1:0]). D\_GPIO operation requires 2-lane FPD-Link III mode. Consult the appropriate Serializer datasheet for details on D\_GPIO configuration. Note: if paired with a DS90UH925Q-Q1serializer, the devices must be configured into 18-bit mode to allow usage of GPIO pins on the serializer. To enable 18-bit mode, set serializer register 0x12[2] = 1. 18-bit mode will be auto-loaded into the deserializer from the serializer. See Table 3 for GPIO enable and configuration.

Description	Device	Forward Channel	Back Channel
GPIO3 / D_GPIO3	Serializer	0x0F[3:0] = 0x3	0x0F[3:0] = 0x5
	Deserializer	0x1F[3:0] = 0x5	0x1F[3:0] = 0x3
GPIO2 / D_GPIO2	Serializer	0x0E[7:4] = 0x3	0x0E[7:4] = 0x5
	Deserializer	0x1E[7:4] = 0x5	0x1E[7:4] = 0x3
GPIO1 / D_GPIO1	Serializer	0x0E[3:0] = 0x3	0x0E[3:0] = 0x5
	Deserializer	0x1E[3:0] = 0x5	0x1E[3:0] = 0x3
GPIO0 / D_GPIO0	Serializer	0x0D[3:0] = 0x3	0x0D[3:0] = 0x5
	Deserializer	0x1D[3:0] = 0x5	0x1D[3:0] = 0x3

The input value present on GPIO[3:0] or D\_GPIO[3:0] may also be read from register, or configured to local output mode (Table 11).

### 8.3.8.2 Back Channel Configuration

The D\_GPIO[3:0] pins can be configured to obtain different sampling rates depending on the mode as well as back channel frequency. The mode is controlled by register 0x43 (Table 11). The back channel frequency can be controlled several ways:

- 1. Register 0x23[6] sets the divider that controls the back channel frequency based on the internal oscillator. 0x23[6] = 0 sets the divider to 4 and 0x23[6] = 1 sets the divider to 2. As long as BC\_HS\_CTL (0x23[4]) is set to 0, the back channel frequency would be either 5 Mbps or 10Mbps based on this bit.
- 2. Register 0x23[4] enables the high-speed back channel. This can also be pin-strapped via MODE\_SEL1 (SeeTable 4). This bit overrides 0x23[6], and sets the divider for the back channel frequency to 1. Setting this bit to 1 sets the back channel frequency to 20 Mbps.

The back channel frequency has variation of  $\pm 20\%$ . Note: The back channel frequency must be set to 5 Mbps when paired with a DS90UH925Q-Q1, DS90UH925AQ-Q1, or DS90UH927Q-Q1. See Table 4 for details about configuring the D\_GPIOs in various modes.

HSCC_MODE	Number of Sa		Samples per	D_GPIO Effective Frequency <sup>(1)</sup> (kHz)			D_GPIOs	
(0x43[2:0])	Mode	D_GPIOs	Frame	5 Mbps BC <sup>(2)</sup>	10 Mbps BC <sup>(3)</sup>	20 Mbps BC <sup>(4)</sup>	Allowed	
000	Normal	4	1	33	66	133	D_GPIO[3:0]	
011	Fast	4	6	200	400	800	D_GPIO[3:0]	
010	Fast	2	10	333	666	1333	D_GPIO[1:0]	
001	Fast	1	15	500	1000	2000	D_GPIO0	

### Table 4. Back Channel D\_GPIO Effective Frequency

(1) The effective frequency assumes the worst case back channel frequency (-20%) and a 4X sampling rate.

(2) 5 Mbps corresponds to BC FREQ SELECT = 0 & BC\_HS\_CTL = 0

<sup>(3) 10</sup> Mbps corresponds to BC FREQ SELECT =  $1 \& BC_HS_CTL = 0$ 

 <sup>(4) 20</sup> Mbps corresponds to BC FREQ SELECT = X & BC\_HS\_CTL = 1

### 8.3.8.3 GPIO\_REG[8:5] Configuration

GPIO\_REG[8:5] are register-only GPIOs and may be programmed as outputs or read as inputs through local register bits only. Where applicable, these bits are shared with I2S pins and will override I2S input if enabled into GPIO\_REG mode. See Table 5 for GPIO enable and configuration.

Note: Local GPIO value may be configured and read either through local register access, or remote register access through the Low-Speed Bidirectional Control Channel. Configuration and state of these pins are not transported from serializer to deserializer as is the case for GPIO[3:0].

Description	Register Configuration	Function
GPIO_REG8	0x21[7:4] = 0x1	Output, L
	0x21[7:4] = 0x9	Output, H
	0x21[7:4] = 0x3	Input, Read: 0x6F[0]
GPIO_REG7	0x21[3:0] = 0x1	Output, L
	0x21[3:0] = 0x9	Output, H
	0x21[3:0] = 0x3	Input, Read: 0x6E[7]
GPIO_REG6	0x20[7:4] = 0x1	Output, L
	0x20[7:4] = 0x9	Output, H
	0x20[7:4] = 0x3	Input, Read: 0x6E[6]
GPIO_REG5	0x20[3:0] = 0x1	Output, L
	0x20[3:0] = 0x9	Output, H
	0x20[3:0] = 0x3	Input, Read: 0x6E[5]
GPIO3	0x1F[3:0] = 0x1	Output, L
	0x1F[3:0] = 0x9	Output, H
	0x1F[3:0] = 0x3	Input, Read: 0x6E[3]
GPIO2	0x1E[7:4] = 0x1	Output, L
	0x1E[7:4] = 0x9	Output, H
	0x1E[7:4] = 0x3	Input, Read: 0x6E[2]
GPIO1	0x1E[3:0] = 0x1	Output, L
	0x1E[3:0] = 0x9	Output, H
	0x1E[3:0] = 0x3	Input, Read: 0x6E[1]
GPIO0	0x1D[3:0] = 0x1	Output, L
	0x1D[3:0] = 0x9	Output, H
	0x1D[3:0] = 0x3	Input, Read: 0x6E[0]

 Table 5. GPIO\_REG and GPIO Local Enable and Configuration

#### 8.3.9 SPI Communication

The SPI Control Channel utilizes the secondary link in a 2-lane FPD-Link III implementation. Two possible modes are available, Forward Channel and Reverse Channel modes. In Forward Channel mode, the SPI Master is located at the Serializer, such that the direction of sending SPI data is in the same direction as the video data. In Reverse Channel mode, the SPI Master is located at the Deserializer, such that the direction of sending SPI data is in the same direction of sending SPI data is in the opposite direction as the video data.

The SPI Control Channel can operate in a high speed mode when writing data, but must operate at lower frequencies when reading data. During SPI reads, data is clocked from the slave to the master on the SPI clock falling edge. Thus, the SPI read must operate with a clock period that is greater than the round trip data latency. On the other hand, for SPI writes, data can be sent at much higher frequencies where the MISO pin can be ignored by the master.

SPI data rates are not symmetrical for the two modes of operation. Data over the forward channel can be sent much faster than data over the reverse channel.

Note: SPI cannot be used to access Serializer / Deserializer registers.



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#### 8.3.9.1 SPI Mode Configuration

SPI is configured over I2C using the High-Speed Control Channel Configuration (HSCC\_CONTROL) register, 0x43 (Table 12). HSCC\_MODE (0x43[2:0]) must be configured for either High-Speed, Forward Channel SPI mode (110) or High-Speed, Reverse Channel SPI mode (111).

#### 8.3.9.2 Forward Channel SPI Operation

In Forward Channel SPI operation, the SPI master located at the Serializer generates the SPI Clock (SPLK), Master Out / Slave In data (MOSI), and active low Slave Select (SS). The Serializer oversamples the SPI signals directly using the video pixel clock. The three sampled values for SPLK, MOSI, and SS are each sent on data bits in the forward channel frame. At the Deserializer, the SPI signals are regenerated using the pixel clock. In order to preserve setup and hold time, the Deserializer will hold MOSI data while the SPLK signal is high. In addition, it delays SPLK by one pixel clock relative to the MOSI data, increasing setup by one pixel clock.

SERIALIZER

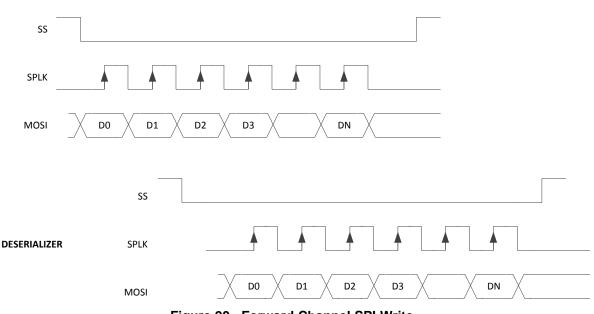
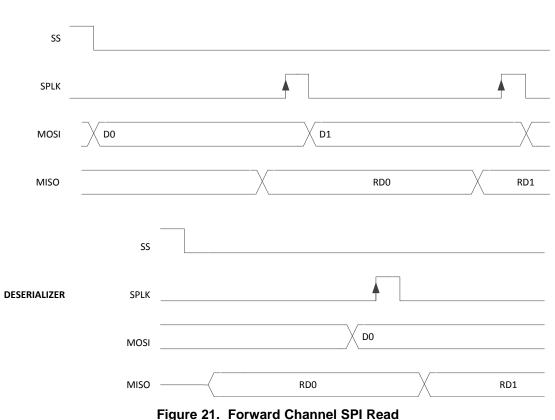


Figure 20. Forward Channel SPI Write

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SERIALIZER

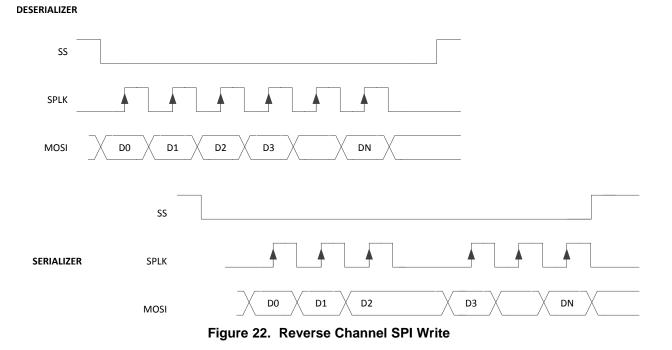


8.3.9.3 Reverse Channel SPI Operation

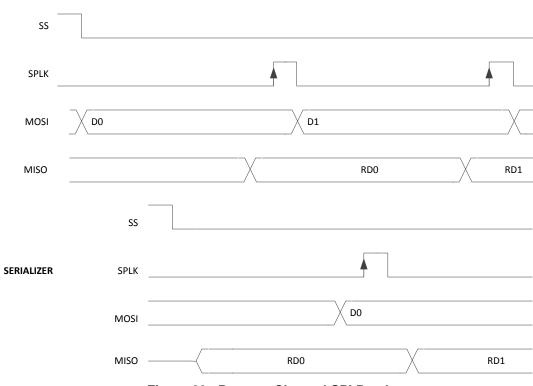
In Reverse Channel SPI operation, the Deserializer samples the Slave Select (SS), SPI clock (SCLK) into the internal oscillator clock domain. In addition, upon detection of the active SPI clock edge, the Deserializer samples the SPI data (MOSI). The SPI data samples are stored in a buffer to be passed to the Serializer over the back channel. The Deserializer sends SPI information in a back channel frame to the Serializer. In each back channel frame, the Deserializer sends an indication of the Slave Select value. The Slave Select should be inactive (high) for at least one back-channel frame period to ensure propagation to the Serializer.

Because data is delivered in separate back channel frames and buffered, the data may be regenerated in bursts. The following figure (Figure 22) shows an example of the SPI data regeneration when the data arrives in three back channel frames. The first frame delivered the SS active indication, the second frame delivered the first three data bits, and the third frame delivers the additional data bits.





For Reverse Channel SPI reads, the SPI master must wait for a round-trip response before generating the sampling edge of the SPI clock. This is similar to operation in Forward channel mode. Note that at most one data/clock sample will be sent per back channel frame.



### Figure 23. Reverse Channel SPI Read

DESERIALIZER

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For both Reverse Channel SPI writes and reads, the SPI\_SS signal should be deasserted for at least one back channel frame period.

Back Channel Frequency	Deassertion Requirement
5 Mbps	7.5 µs
10 Mbps	3.75 µs
20 Mbps	1.875 µs

Table 6. SPI SS Deassertion Requirer
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### 8.3.10 Backward Compatibility

The DS90UH940-Q1 is also backward compatible to the DS90UH925Q-Q1, DS90UH925AQ-Q1, and DS90UH927Q-Q1 for PCLK frequencies ranging from 25MHz to 85MHz. Backward compatibility does not need to be enabled. When paired with a backward compatible device, the Deserializer will auto-detect to 1-lane FPD-Link III on the primary channel (RIN0±).

### 8.3.11 Input Equalization

An FPD-Link III input adaptive equalizer provides compensation for transmission medium losses and reduces medium-induced deterministic jitter. It equalizes up to 15m STP or  $50\Omega$  Coaxial cables with 3 connection breaks at maximum serializer stream payload of 3.36 Gbps.

### 8.3.12 I2S Audio Interface

This Deserializer features six I2S output pins that, when paired with a compatible serializer, supports surround sound audio applications. The bit clock (I2S\_CLK) supports frequencies between 1MHz and the smaller of <PCLK/2 or <13MHz. Four I2S data outputs carry two channels of I2S-formatted digital audio each, with each channel delineated by the word select (I2C\_WC) input.

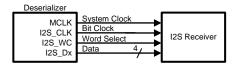


Figure 24. I2S Connection Diagram

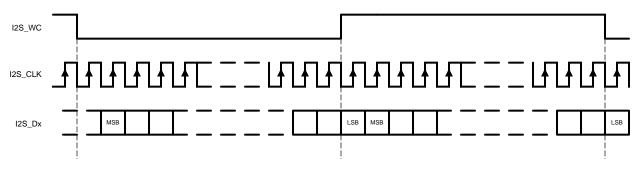


Figure 25. I2S Frame Timing Diagram

When paired with a DS90UH925Q, the Deserializer I2S interface supports a single I2S data output through I2S\_DA (24-bit video mode), or two I2S data outputs through I2S\_DA and I2S\_DB (18-bit video mode).



#### 8.3.12.1 I2S Transport Modes

By default, packetized audio is received during video blanking periods in dedicated Data Island Transport frames. The transport mode is set in the serializer and auto-loaded into the deserializer by default. The audio configuration may be disabled from control registers if Forward Channel Frame Transport of I2S data is desired. In frame transport, only I2S\_DA is received to the Deserializer. Surround Sound Mode, which transmits all four I2S data inputs (I2S\_D[D:A]), may only be operated in Data Island Transport mode. This mode is only available when connected to a DS90UH927Q, DS90UH949-Q1, DS90UH947-Q1, or DS90UH929-Q1 serializer. If connected to a DS90UH925Q serializer, only I2S\_DA and I2S\_DB may be received.

### 8.3.12.2 I2S Jitter Cleaning

This device features a standalone PLL to clean the I2S data jitter, supporting high-end car audio systems. If I2S\_CLK frequency is less than 1MHz, this feature must be disabled through register 0x2B[7]. See Table 12.

### 8.3.12.3 MCLK

The deserializer has an I2S Master Clock Output (MCLK). It supports x1, x2, or x4 of I2S CLK Frequency. When the I2S PLL is disabled, the MCLK output is off. Table 7 covers the range of I2S sample rates and MCLK frequencies. By default, all the MCLK output frequencies are x2 of the I2S CLK frequencies. The MCLK frequencies can also be enabled through the register bits 0x3A[6:4] (I2S DIVSEL), shown in Table 12. To select desired MCLK frequency, write 0x3A[7], then write to bit [6:4] accordingly.

Sample Rate (kHz)	I2S Data Word Size (bits)	I2S_CLK (MHz)	MCLK Output (MHz)	Register 0x3A[6:4]	
			I2S_CLK x1	000	
32		1.024	I2S_CLK x2	001	
			I2S_CLK x4	010	
			I2S_CLK x1	000	
44.1		1.4112	I2S_CLK x2	001	
			I2S_CLK x4	010	
	16		I2S_CLK x1	000	
48		16	1.536	I2S_CLK x2	001
			I2S_CLK x4	010	
			I2S_CLK x1	001	
96		3.072	I2S_CLK x2	010	
			I2S_CLK x4	011	
			I2S_CLK x1	010	
192		6.144	I2S_CLK x2	011	
			I2S_CLK x4	100	

### **Table 7. Audio Interface Frequencies**

Sample Rate (kHz)	I2S Data Word Size (bits)	I2S_CLK (MHz)	MCLK Output (MHz)	Register 0x3A[6:4]
32		1.536	I2S_CLK x1	000
			I2S_CLK x2	001
			I2S_CLK x4	010
44.1		2.117	I2S_CLK x1	001
			I2S_CLK x2	010
			I2S_CLK x4	011
48		2.304	I2S_CLK x1	001
			I2S_CLK x2	010
			I2S_CLK x4	011
96		4.608	I2S_CLK x1	010
			I2S_CLK x2	011
			I2S_CLK x4	100
192		9.216	I2S_CLK x1	011
			I2S_CLK x2	100
			I2S_CLK x4	101
32	32 32 6.14	2.048	I2S_CLK x1	001
			I2S_CLK x2	010
			I2S_CLK x4	011
44.1		2.8224	I2S_CLK x1	001
			I2S_CLK x2	010
			I2S_CLK x4	011
48		3.072	I2S_CLK x1	001
			I2S_CLK x2	010
			I2S_CLK x4	011
96		6.144	I2S_CLK x1	010
			I2S_CLK x2	011
			I2S_CLK x4	100
192			I2S_CLK x1	011
		12.288	I2S_CLK x2	100
			I2S_CLK x4	110

### Table 7. Audio Interface Frequencies (continued)

### 8.3.13 HDCP

The HDCP Cipher function is implemented in the deserializer per HDCP v1.4 specification. The DS90UH940-Q1 provides HDCP decryption of audiovisual content when connected to an HDCP capable FPD-Link III serializer. HDCP authentication and shared key generation is performed using the HDCP Control Channel, which is embedded in the forward and backward channels of the serial link. On-chip Non-Volatile Memory (NVM) is used to store the HDCP keys. The confidential HDCP keys are loaded by TI during the manufacturing process and are not accessible external to the device.

### 8.3.13.1 HDCP I2S Audio Encryption

Depending on the quality and specifications of the audiovisual source, HDCP encryption of digital audio may be required. When HDCP is active, packetized Data Island Transport audio is also encrypted along with the video data per HDCP v1.4. I2S audio transmitted in Forward Channel Frame Transport mode is not encrypted. System designers should consult the specific HDCP specifications to determine if encryption of digital audio is required by the specific application audiovisual source.

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#### 8.3.14 Built-In Self Test (BIST)

An optional At-Speed Built-In Self Test (BIST) feature supports testing of the high speed serial link and the lowspeed back channel without external data connections. This is useful in the prototype stage, equipment production, in-system test, and system diagnostics.

### 8.3.14.1 BIST Configuration And Status

The BIST mode is enabled at the deserializer by pin (BISTEN) or BIST configuration register. The test may select either an external PCLK or the 33 MHz internal Oscillator clock (OSC) frequency in the Serializer. In the absence of PCLK, the user can select the internal OSC frequency at the deserializer through the BISTC pin or BIST configuration register.

When BIST is activated at the deserializer, a BIST enable signal is sent to the serializer through the Back Channel. The serializer outputs a test pattern and drives the link at speed. The deserializer detects the test pattern and monitors it for errors. The deserializer PASS output pin toggles to flag each frame received containing one or more errors. The serializer also tracks errors indicated by the CRC fields in each back channel frame.

The BIST status can be monitored real time on the deserializer PASS pin, with each detected error resulting in a half pixel clock period toggled LOW. After BIST is deactivated, the result of the last test is held on the PASS output until reset (new BIST test or Power Down). A high on PASS indicates NO ERRORS were detected. A Low on PASS indicates one or more errors were detected. The duration of the test is controlled by the pulse width applied to the deserializer BISTEN pin. LOCK status is valid throughout the entire duration of BIST.

See Figure 26 for the BIST mode flow diagram.

#### 8.3.14.1.1 Sample BIST Sequence

**Note:** Before BIST can be enabled, D\_GPIO0 (pin 19) must be strapped HIGH and D\_GPIO[3:1] (pins 16, 17, and 18) must be strapped LOW.

- 1. BIST Mode is enabled via the BISTEN pin of Deserializer. The desired clock source is selected through the deserializer BISTC pin.
- 2. The serializer is awakened through the back channel if it is not already on. An all-zeros pattern is balanced, scrambled, randomized, and sent through the FPD-Link III interface to the deserializer. Once the serializer and the deserializer are in BIST mode and the deserializer acquires LOCK, the PASS pin of the deserializer goes high and BIST starts checking the data stream. If an error in the payload (1 to 35) is detected, the PASS pin will switch low for one half of the clock period. During the BIST test, the PASS output can be monitored and counted to determine the payload error rate per 35 bits.
- 3. To Stop BIST mode, set the BISTEN pin LOW. The deserializer stops checking the data, and the final test result is held on the PASS pin. If the test ran error free, the PASS output will remain HIGH. If there one or more errors were detected, the PASS output will output constant LOW. The PASS output state is held until a new BIST is run, the device is RESET, or the device is powered down. BIST duration is user-controlled and may be of any length.

The link returns to normal operation after the deserializer BISTEN pin is low. Figure 27 shows the waveform diagram of a typical BIST test for two cases. Case 1 is error free, and Case 2 shows one with multiple errors. In most cases it is difficult to generate errors due to the robustness of the link (differential data transmission etc.), thus they may be introduced by greatly extending the cable length, faulting the interconnect medium, or reducing signal condition enhancements (Rx Equalization).

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TEXAS INSTRUMENTS

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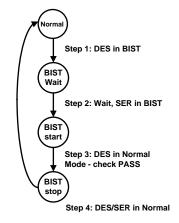


Figure 26. BIST Mode Flow Diagram

### 8.3.14.2 Forward Channel and Back Channel Error Checking

The Deserializer, on locking to the serial stream, compares the recovered serial stream with all-zeroes and records any errors in status registers. Errors are also dynamically reported on the PASS pin of the deserializer. Forward channel errors may also be read from register 0x25 (Table 12).

The back-channel data is checked for CRC errors once the serializer locks onto the back-channel serial stream, as indicated by link detect status (register bit 0x0C[0] - Table 12). CRC errors are recorded in an 8-bit register in the serializer. The register is cleared when the serializer enters the BIST mode. As soon as the serializer enters BIST mode, the functional mode CRC register starts recording any back channel CRC errors. The BIST mode CRC error register is active in BIST mode only and keeps the record of the last BIST run until cleared or the serializer enters BIST mode again.

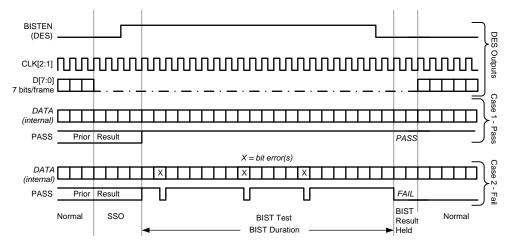


Figure 27. BIST Waveforms

### 8.3.15 Internal Pattern Generation

The deserializer supports the internal pattern generation feature. It allows basic testing and debugging of an integrated panel. The test patterns are simple and repetitive and allow for a quick visual verification of panel operation. As long as the device is not in power down mode, the test pattern will be displayed even if no parallel input is applied. If no PCLK is received, the test pattern can be configured to use a programmed oscillator frequency. For detailed information, refer to Application Note AN-2198 (SNLA132).



### 8.4 Device Functional Modes

### 8.4.1 Configuration Select

The DS90UH940-Q1 can be configured for several different operating modes via the MODE\_SEL[1:0] input pins, or via the register bits 0x23 [4:3] (MODE\_SEL1) and 0x6A [5:4] (MODE\_SEL0). A pull-up resistor and a pull-down resistor of suggested values may be used to set the voltage ratio of the MODE\_SEL[1:0] input and VDD33 to select one of the possible selected modes.

The DS90UH940-Q1 is capable of operating in either in 1-lane or 2-lane modes for FPD-Link III. By default, the FPD-Link III receiver automatically configures the input based on 1- or 2-lane mode operation. Programming register 0x34 [4:3] settings will override the automatic detection. For each FPD-Link III pair, the serial datastream is composed of a 35-bit symbol.

The DS90UH940-Q1 recovers the FPD-Link III serial datastream(s) and produces CSI-2 TX data driven to the MIPI DPHY interface. There are two CSI-2 ports (CSI0\_Dn and CSI1\_Dn) and each consist of one clock lane and four data lanes. The DS90UH940-Q1 supports two CSI-2 TX ports, and each may be configured to support either two or four CSI-2 data lanes. Unused CSI-2 outputs are driven to LP11 states. The MIPI DPHY transmission operates in both differential (HS) and single-ended (LP) modes. During HS transmission, the pair of outputs operates in differential mode; and in LP mode, the pair operates as two independent single-ended traces. Both the data and clock lanes enter LP mode during the horizontal and vertical blanking periods.

The configurations outlined in (*1-lane FPD-Link III Input, 4 MIPI lanes Output, 1-lane FPD-Link III Input, 2 MIPI lanes Output,* 1- or 2-lane FPD-Link III Input, 2 or 4 MIPI lanes Output in Replicate) will apply to DS90UH949-Q1, DS90UH947-Q1, DS90UH929-Q1, DS90UH925Q-Q1, DS90UH925AQ-Q1, and DS90UH927Q-Q1 FPD-Link III Serializers.

The configurations outlined in (2-lane FPD-Link III Input, 4 MIPI lanes Output, 2-lane FPD-Link III Input, 2 MIPI lanes Output, 1- or 2-lane FPD-Link III Input, 2 or 4 MIPI lanes Output in Replicate) will apply to DS90UH949-Q1 and DS90UH947-Q1 FPD-Link III Serializers.

The device can be configured in following modes:

- 1-lane FPD-Link III Input, 4 MIPI lanes Output
- 1-lane FPD-Link III Input, 2 MIPI lanes Output
- 2-lane FPD-Link III Input, 4 MIPI lanes Output
- 2-lane FPD-Link III Input, 4 MIPI lanes Output
- 1- or 2-lane FPD-Link III Input, 2 or 4 MIPI lanes Output (Replicate)

#### 8.4.1.1 1-lane FPD-Link III Input, 4 MIPI lanes Output

In this configuration the PCLK rate embedded within the 1-lane FPD-Link III frame can range from 25 MHz to 96 MHz, resulting in a link rate of 875 Mbps (35 bit \* 25 MHz) to 3.36 Gbps (35 bit \* 96 MHz). Each MIPI data lane will operate at a speed of 7 \* PCLK frequency; resulting in a data rate of 175 Mbps to 672 Mbps. The corresponding MIPI transmit clock rate will operate between 87.5 MHz to 336 MHz.

#### 8.4.1.2 1-lane FPD-Link III Input, 2 MIPI lanes Output

In this configuration the PCLK rate embedded within the 1-lane FPD-Link III frame can range from 25 MHz to 96 MHz, resulting in a link rate of 875 Mbps (35 bit \* 25 MHz) to 3.36 Gbps (35 bit \* 96 MHz). Each MIPI data lane will operate at a speed of 14 \* PCLK frequency; resulting in a data rate of 350 Mbps to 1344 Mbps. The corresponding MIPI transmit clock rate will operate between 175 MHz to 672 MHz.

#### 8.4.1.3 2-lane FPD-Link III Input, 4 MIPI lanes Output

In this configuration the PCLK rate embedded is split into 2-lane FPD-Link III frame and can range from 50 MHz to 170 MHz, resulting in a link rate of 875 Mbps (35 bit \* 25 MHz) to 2.975 Gbps (35 bit \* 85 MHz). The embedded datastreams from the received FPD-Link III inputs are merged in HS mode to form packets that carry the video stream. Each MIPI data lane will operate at a speed of 7 \* PCLK frequency, resulting in a data rate of 350 Mbps to 1190 Mbps. The corresponding MIPI transmit clock rate will operate between 175 MHz to 595 MHz.

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### **Device Functional Modes (continued)**

#### 8.4.1.4 2-lane FPD-Link III Input, 2 MIPI lanes Output

In this configuration the PCLK rate embedded is split into 2-lane FPD-Link III frame and can range from 25 MHz to 48 MHz, resulting in a link rate of 875 Mbps (35 bit \* 25 MHz) to 1.680 Gbps (35 bit \* 48 MHz). The embedded datastreams from the received FPD-Link III inputs are merged in HS mode to form packets that carry the video stream. Each MIPI data lane will operate at a speed of 14 \* PCLK frequency, resulting in a data rate of 700 Mbps to 1344 Mbps. The corresponding MIPI transmit clock rate will operate between 350 MHz to 672 MHz.

#### 8.4.1.5 1- or 2-lane FPD-Link III Input, 2 or 4 MIPI lanes Output in Replicate

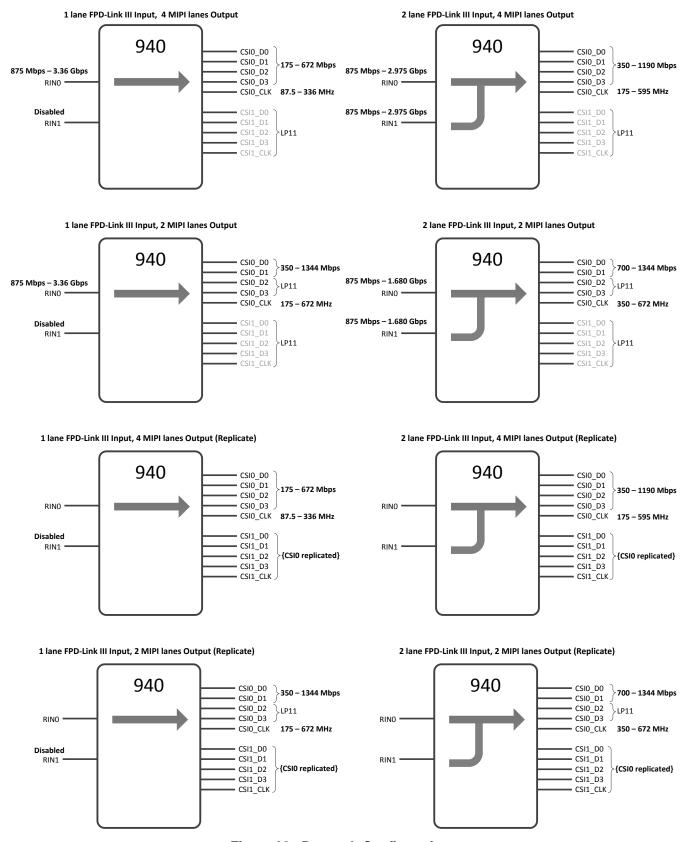
Same as 1- or 2-lane FPD-Link III Input(s), duplicates the MIPI CSI-2 lanes on CSI1\_D[3:0] and CSI1\_CLK outputs.

#### 8.4.2 MODE\_SEL[1:0]

Configuration of the device may be done via the MODE\_SEL[1:0] input pins, or via the configuration register bits. A pull-up resistor and a pull-down resistor of suggested values may be used to set the voltage ratio of the MODE\_SEL[1:0] inputs ( $V_{R4}$ ) and VDD33 to select one of the other 8 possible selected modes. See Table 8 and Table 9. Possible configurations are shown in Figure 28.



## **Device Functional Modes (continued)**

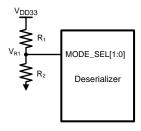


### Figure 28. Datapath Configurations

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### **Device Functional Modes (continued)**

Configuration of the device may be done via the MODE\_SEL[1:0] input pins, or via the configuration register bits. A pull-up resistor and a pull-down resistor of suggested values may be used to set the voltage ratio of the MODE\_SEL[1:0] inputs ( $V_{R1}$ ) and VDD33 to select one of the other 8 possible selected modes. See Table 8 and Table 9.



### Figure 29. MODE\_SEL[1:0] Connection Diagram

#	ldeal Ratio V <sub>R1</sub> /VDD33	Target V <sub>R1</sub> (V)	Suggested Resistor R1 kΩ (1% tol)	Suggested Resistor R2 kΩ (1% tol)	Output Mode						
1	0	0	Open	40.2 or Any	4 data lanes 1 CSI port active (determined by MODE_SEL1 CSI_SEL bit)						
2	0.169	0.559	232	47.5	4 data lanes both CSI ports active (overrides MODE_SEL1)						
3	0.230	0.757	107	31.6	2 data lanes 1 CSI port active (determined by MODE_SEL1 CSI_SEL bit)						
4	0.295	0.974	113	47.5	2 data lanes both CSI port active (overrides MODE_SEL1)						
5	0.376	1.241	113	68.1	RESERVED						
6	0.466	1.538	107	93.1	RESERVED						
7	0.556	1.835	90.9	113	RESERVED						
8	0.801	2.642	45.3	182	RESERVED						

#### Table 8. Configuration Select (MODE\_SEL0)

### Table 9. Configuration Select (MODE\_SEL1)

#	Ideal Ratio V <sub>R1</sub> /VDD33	Target V <sub>R1</sub> (V)	Suggested Resistor R1 kΩ (1% tol)	Suggested Resistor R2 kΩ (1% tol)	CSI_SEL (CSI PORT)	High Speed Back Channel	Input Mode
1	0	0	Open	40.2 or Any	CSI0	5 Mbps	STP
2	0.169	0.559	232	47.5	CSI0	5 Mbps	Coax
3	0.230	0.757	107	31.6	CSI0	20 Mbps	STP
4	0.295	0.974	113	47.5	CSI0	20 Mbps	Coax
5	0.376	1.241	113	68.1	CSI1	5 Mbps	STP
6	0.466	1.538	107	93.1	CSI1	5 Mbps	Coax
7	0.556	1.835	90.9	113	CSI1	20 Mbps	STP
8	0.801	2.642	45.3	182	CSI1	20 Mbps	Coax



#### 8.4.3 CSI-2 Interface

The DS90UH940-Q1 (in default mode) takes RGB 24-bpp data bits defined in the serializer and directly maps to the pixel color space in the data frame. The DS90UH940-Q1 follows the general frame format as described per the CSI-2 standard (Figure 30). Upon the end of the vertical sync pulse (VS), the DS90UH940-Q1 generates the Frame End and Frame Start synchronization packets within the vertical blanking period. The timing of the Frame Start will not reflect the timing of the VS signal.

Upon the rising edge of the DE signal, each active line is output in a long data packet with the defined data format (Figure 13). At the end of each packet, the data lanes  $Dn\pm$  return to the LP-11 state, while the clock lane CLK± continue outputting the high speed clock.

The DS90UH940-Q1 CSI-2 transmitter consists of a high speed clock (CLK $\pm$ ) and data (Dn $\pm$ ) outputs based on a source synchronous interface. The half rate clock at CLK $\pm$  is derived from the pixel clock sourced by the clock/data recovery circuit of the DS90UH940-Q1. The CSI-2 clock frequency is 3.5 times (4 MIPI lanes) or 7 times (2 MIPI lanes) the recovered pixel clock frequency. The MIPI DPHY outputs either 2 or 4 high speed data lanes (Dn $\pm$ ) according to the CSI-2 protocol. The data rate of each lane is 7 times (4 MIPI lanes) or 14 times (2 MIPI lanes) the pixel clock. As an example in a 4 MIPI lane configuration, at a pixel clock of 150 MHz, the CLK $\pm$  runs at 525 MHz, and each data lane runs at 1050 Mbps.

The half-rate clock maintains a quadrature phase relationship to the data signals and allows receiver to sample data at the rising and falling edges of the clock (DDR). Figure 10 shows the timing relationship of the clock and data lines. The DS90UH940-Q1 supports continuous high speed clock. High speed data are sent out at data lanes Dn± in bursts. In between data bursts, the data lanes return to Low Power (LP) States in according to protocol defined in D-PHY standard. The rising edge of the differential clock (CSI\_CLK+ – CSI\_CLK-) is sent during the first payload bit of a transmission burst in the data lanes.

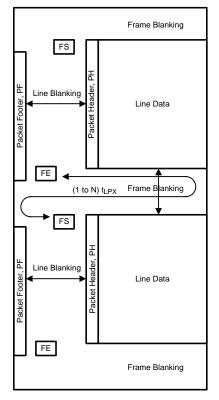


Figure 30. CSI-2 General Frame Format

### 8.4.4 Input Display Timing

The DS90UH940-Q1 has built-in support to detect the incoming video format extracted from the FPD-Link III datastream(s) and automatically generate CSI-2 output timing parameters accordingly. The input video format detection is derived from progressive display resolutions based on the CEA-861D specification. The video data rate and frame rate is determined by measuring internal VS and DE signals.

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### 8.4.5 MIPI CSI-2 Output Data Formats

The DS90UH940-Q1 CSI-2 Tx supports multiple data types. These can be seen in Table 10.

Data Format	CSI-2 Data Type [5:0]	Reg0x6B [3:2] IFMT	Reg0x6B [7:4] OFMT	Description						
RGB888	0x24	00	0000	RGB888 image data – using 24-bit container for RGB 24-bpp						
RGB666	0x23	00	0001	RGB666 image data						
RGB565	0x22	00	0010	RGB565 image data						
YUV420	0x1A	00	0011	YUV4:2:0 image data, Legacy YUV420 8-bit						
YUV420 8-bit	0x18	00	0100	YUV4:2:0 image data						
YUV422 8-bit	0x1E	00	0101	YUV4:2:2 image data						
RAW8	0x2A	11	0110	RAW Bayer, 8-bit image data D[0:7] of Serializer inputs are used as RAW data; Alignment is configured with CSIIA_{0x6C}_0x09 [4]						
RAW10	0x2B	11	0111	RAW Bayer, 10-bit image data D[0:9] of Serializer inputs are used as RAW data; Alignment is configured with CSIIA_{0x6C}_0x09 [4]						
RAW12	0x2C	11	1000	RAW Bayer, 12-bit image data D[0:11] of Serializer inputs are used as RAW data; Alignment is configured with CSIIA_{0x6C}_0x09 [4]						
YUV420 8-bit (CSPS)	0x1C	00	1001	YUV4:2:0 image data, YUV420 Chroma Shifted Pixel Sampling						

#### Table 10. CSI-2 Output Data Formats<sup>(1)</sup>

(1) Note: Color space conversion is only available from RGB to YUV.

#### 8.4.6 Non-Continuous / Continuous Clock

DS90UH940-Q1 D-PHY supports Continuous clock mode and Non-Continuous clock mode on the CSI-2 interface. Default mode is Non-Continuous Clock mode, where the Clock Lane enters in LP mode between the transmissions of data packets. Non-continuous clock mode will only be non-continuous during the vertical blanking period for lower PCLK rates. For higher PCLK rates, the clock will be non-continuous between line and frame packets. Operating modes are configurable through 0x6A [1].

Clock lane enters LP11 during horizontal blanking if the horizontal blanking period is longer than the overhead time to start/stop the clock lane. There is auto-detection of the length of the horizontal blank period. The fixed threshold is 96 PCLK cycles.

#### 8.4.7 Ultra Low Power State (ULPS)

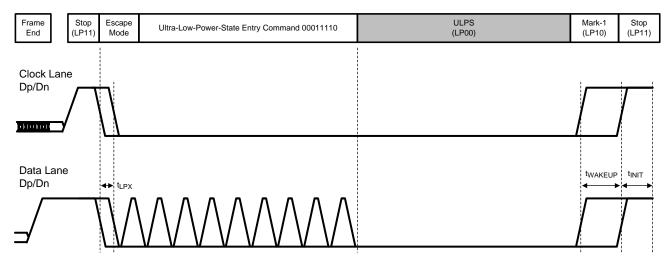
The DS90UH940-Q1 supports the MIPI defined Ultra-Low Power State (ULPS). DS90UH940-Q1 D-PHY lanes will enter ULPS mode upon software standby mode through 0x6A [2] generated by the processor. When ULPS is issued, all active CSI-2 lanes including the clock and data lanes of the enabled CSI-2 port are put in ULPS according to the MIPI DPHY protocol. D-PHY can reduce power consumption by entering ULPS mode. Ultra Low Power State is exited by means of a Mark-1 state with a length TWAKEUP followed by a Stop state.



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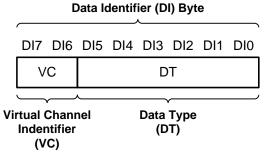


### Figure 31. Ultra Low Power State

#### 8.4.8 CSI-2 Data Identifier

The DS90UH940-Q1 MIPI CSI-2 protocol interface transmits the data identifier byte containing the values for the virtual channel ID (VC) and data type (DT) for the application specific payload data, as shown in Figure 32. The virtual channel ID is contained in the 2 MSBs of the data identifier byte and identify the data as directed to one of four virtual channels. The value of the data type is contained in the 6 LSBs of the data identifier byte.

- CSIIA\_{0x6C}\_0x2E[7:6] CSI\_VC\_ID: Configures the virtual ID linked to the current context.
- CSICFG1\_0x6B[7:4] OFMT: Configures the data format linked to the current context.





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### 8.5 Programming

DS90UH940-Q1

#### 8.5.1 Serial Control Bus

The device may also be configured by the use of a I2C compatible serial control bus. Multiple devices may share the serial control bus (up to 8 device addresses supported). The device address is set via a resistor divider (R1 and R2 — see Figure 33 below) connected to the IDx pin.

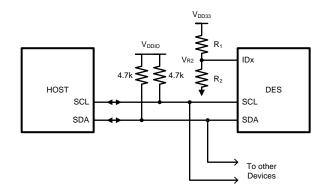


Figure 33. Serial Control Bus Connection

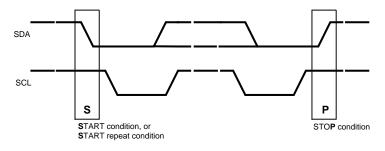
The serial control bus consists of two signals, SCL and SDA. SCL is a Serial Bus Clock Input. SDA is the Serial Bus Data Input / Output signal. Both SCL and SDA signals require an external pull-up resistor to 1.8 V or 3.3 V VDDIO. For most applications, a  $4.7k\Omega$  pull-up resistor to VDD33 is recommended. However, the pull-up resistor value may be adjusted for capacitive loading and data rate requirements. The signals are either pulled High, or driven Low.

The IDx pin configures the control interface to one of 8 possible device addresses. A pull-up resistor and a pulldown resistor may be used to set the appropriate voltage ratio between the IDx input pin ( $V_{R2}$ ) and VDD33, each ratio corresponding to a specific device address. See Table 11 below.

#	Ideal Ratio V <sub>R2</sub> / VDD33	ldeal V <sub>R2</sub> (V)	Suggested Resistor R1 kΩ (1% tol)	Suggested Resistor R2 kΩ (1% tol)	7-bit Address	8-bit Address
1	0	0	Open	40.2 or >10	0x2C	0x58
2	0.169	0.559	232	47.5	0x2E	0x5C
3	0.230	0.757	107	31.6	0x30	0x60
4	0.295	0.974	113	47.5	0x32	0x64
5	0.376	1.241	113	68.1	0x34	0x68
6	0.466	1.538	107	93.1	0x36	0x6C
7	0.556	1.835	90.9	113	0x38	0x70
8	0.801	2.642	45.3	182	0x3C	0x78

 Table 11. Serial Control Bus Addresses for IDx

The Serial Bus protocol is controlled by START, START-Repeated, and STOP phases. A START occurs when SCL transitions Low while SDA is High. A STOP occurs when SDA transitions High while SCL is also HIGH. See Figure 34







To communicate with a remote device, the host controller (master) sends the slave address and listens for a response from the slave. This response is referred to as an acknowledge bit (ACK). If a slave on the bus is addressed correctly, it Acknowledges (ACKs) the master by driving the SDA bus low. If the address doesn't match a device's slave address, it Not-acknowledges (NACKs) the master by letting SDA be pulled High. ACKs also occur on the bus when data is being transmitted. When the master is writing data, the slave ACKs after every data byte is successfully received. When the master is reading data, the master ACKs after every data byte is received to let the slave know it wants to receive another data byte. When the master wants to stop reading, it NACKs after the last data byte and creates a stop condition on the bus. All communication on the bus begins with either a Start condition or a Repeated Start condition. All communication on the bus ends with a Stop condition. A READ is shown in Figure 35 and a WRITE is shown in Figure 36.





Figure 36. Serial Control Bus — WRITE

The I2C Master located at the Deserializer must support I2C clock stretching. For more information on I2C interface requirements and throughput considerations, please refer to TI Application Note SNLA131.

### 8.5.2 Multi-Master Arbitration Support

The Bidirectional Control Channel in the FPD-Link III devices implements I2C compatible bus arbitration in the proxy I2C master implementation. When sending a data bit, each I2C master senses the value on the SDA line. If the master is sending a logic 1 but senses a logic 0, the master has lost arbitration. It will stop driving SDA, retrying the transaction when the bus becomes idle. Thus, multiple I2C masters may be implemented in the system.

For example, there might also be a local I2C master at each camera. The local I2C master could access the Image Sensor and EEPROM. The only restriction would be that the remote I2C master at the camera should not attempt to access a remote slave through the BCC that is located at the host controller side of the link. In other words, the control channel should only operate in camera mode for accessing remote slave devices to avoid issues with arbitration across the link. The remote I2C master should also not attempt to access the deserializer registers to avoid a conflict in register access with the Host controller.

If the system does require master-slave operation in both directions across the BCC, some method of communication must be used to ensure only one direction of operation occurs at any time. The communication method could include using available read/write registers in the deserializer to allow masters to communicate with each other to pass control between the two masters. An example would be to use register 0x18 or 0x19 in the deserializer as a mailbox register to pass control of the channel from one master to another.

#### 8.5.3 I2C Restrictions on Multi-Master Operation

The I2C specification does not provide for arbitration between masters under certain conditions. The system should make sure the following conditions cannot occur to prevent undefined conditions on the I2C bus:

- One master generates a repeated Start while another master is sending a data bit.
- · One master generates a Stop while another master is sending a data bit.
- One master generates a repeated Start while another master sends a Stop.

Note that these restrictions mainly apply to accessing the same register offsets within a specific I2C slave.

#### 8.5.4 Multi-Master Access to Device Registers for Newer FPD-Link III Devices

When using the latest generation of FPD-Link III devices (DS90UH94x-Q1), serializers or deserializer registers may be accessed simultaneously from both local and remote I2C masters. These devices have internal logic to properly arbitrate between sources to allow proper read and write access without risk of corruption.

Access to remote I2C slaves would still be allowed in only one direction at a time (Camera or Display mode).

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#### 8.5.5 Multi-Master Access to Device Registers for Older FPD-Link III Devices

When using older FPD-Link III devices (in backward compatible), simultaneous access to serializer or deserializer registers from both local and remote I2C masters may cause incorrect operation, thus restrictions should be imposed on accessing of serializer and deserializer registers. The likelihood of an error occurrence is relatively small, but it is possible for collision on reads and writes to occur, resulting in an errored read or write.

Two basic options are recommended. The first is to allow device register access only from one controller. In a Display mode system, this would allow only the Host controller to access the serializer registers (local) and the deserializer registers (remote). A controller at the deserializer (local to the Display) would not be allowed to access the deserializer or serializer registers.

The second basic option is to allow local register access only with no access to remote serializer or deserializer registers. The Host controller would be allowed to access the serializer registers while a controller at the deserializer could access those register only. Access to remote I2C slaves would still be allowed in one direction (Camera or Display mode).

In a very limited case, remote and local access could be allowed to the deserializer registers at the same time. Register access is ensured to work correctly if both local and remote masters are accessing the same deserializer register. This allows a simple method of passing control of the Bidirectional Control Channel from one master to another.

#### 8.5.6 Restrictions on Control Channel Direction for Multi-Master Operation

Only Display or Camera mode operation should be active at any time across the Bidirectional Control Channel. If both directions are required, some method of transferring control between I2C masters should be implemented.

NSTRUMENTS

**EXAS** 



## 8.6 Register Maps

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x00	I2C Device ID	7:1	DEVICE ID	RW	Strap	7-bit address of Deserializer; Defaults to the address configured by the IDx strap pin. See Table 11.
		0	DES ID	RW	0	0: Device ID is from IDx strap 1: Register I2C Device ID overrides IDx strap
0x01	Reset	7:3	RESERVED	RW	0	Reserved
		2	RESERVED	R	1	Reserved
		1	DIGITAL RESET0	RW	0	Digital Reset. Resets the entire digital block including registers. This bit is self-clearing. 1: Reset 0: Normal operation. Registers which are loaded by pin strap will be restored to their original strap value when this bit is set. These registers show 'Strap' as their default value in this table.
		0	DIGITAL RESET1	RW	0	Digital Reset. Resets the entire digital block except registers. This bit is self-clearing. 1: Reset 0: Normal operation
0x02	General Configuration 0	7	OUTPUT ENABLE	RW	1	Output Enable Override Value (in conjunction with Output Sleep State Select) If the Override control is not set, the Output Enable will be set to 1. A Digital reset 0x01[0] should be asserted after toggling Output Enable bit <i>LOW</i> to <i>HIGH</i>
		6	OUTPUT ENABLE OVERRIDE	RW	0	Overrides Output Enable and Output Sleep State default 0: Disable override 1: Enable override
		5	OSC CLOCK OUTPUT ENABLE (AUTO_CLOCK_ EN)	RW	0	OSC clock output enable If loss of lock OSC clock is output onto PCLK. The frequency is selected in register 0x24. 1: Enable 0: Disable
		4	OUTPUT SLEEP STATE SELECT	RW	0	OSS Select Override value to control output state when LOCK is low (used in conjunction with Output Enable) If the Override control is not set, the Output Sleep State Select will be set to 1.
		3:0	RESERVED	RW	0	Reserved

### Table 12. Serial Control Bus Registers

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# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x03 General 7 RESERVED RW 1 Reserved		Reserved				
	Configuration 1	6	BC CRC GENERATOR ENABLE	RW	1	Back Channel CRC Generator Enable 0: Enable 1: Disable (Default)
		5	FAILSAFE LOW	RW	1	Controls the pull direction for undriven LVCMOS inputs 1: Pull down 0: Pull up
		4	FILTER ENABLE	RW	1	HS,VS,DE two clock filter When enabled, pulses less than two full PCLK cycles on the DE, HS, and VS inputs will be rejected. 1: Filtering enable 0: Filtering disable
		3	I2C PASS- THROUGH	RW	0	I2C Pass-Through to Serializer if decode matches 0: Pass-Through Disabled 1: Pass-Through Enabled
		2	AUTO ACK	RW	0	Automatically Acknowledge I2C writes independent of the forward channel lock state 1: Enable 0: Disable
		1	DE GATE RGB	RW	0	Gate RGB data with DE signal. RGB data is gated with DE in order to allow packetized audio and block unencrypted data when paired with a serializer that supports HDCP. When paired with a serializer that does not support HDCP, RGB data is not gated with DE by default. However, to enable packetized autio this bit must be set. 1: Gate RGB data with DE (has no effect when paired with a serializer that supports HDCP) 0: Pass RGB data independent of DE (has no effect when paired with a serializer that does not support HDCP)
		0	RESERVED	RW	0	Reserved
0x04	BCC Watchdog Control	7:1	BCC WATCHDOG TIMER	RW	0x7F	The watchdog timer allows termination of a control channel transaction if it fails to complete within a programmed amount of time. This field sets the Bidirectional Control Channel Watchdog Timeout value in units of 2 milliseconds. This field should not be set to 0.
		0	BCC WATCHDOG TIMER DISABLE	RW	0	Disable Bidirectional Control Channel Watchdog Timer 1: Disables BCC Watchdog Timer operation 0: Enables BCC Watchdog Timer operation
0x05	I2C Control 1	7	I2C PASS THROUGH ALL	RW	0	I2C Pass-Through All Transactions 0: Disabled 1: Enabled
		6:4	I2C SDA HOLD	RW	0x1	Internal SDA Hold Time This field configures the amount of internal hold time provided for the SDA input relative to the SCL input. Units are 50 nanoseconds.
		3:0	I2C FILTER DEPTH	RW	0xE	I2C Glitch Filter Depth This field configures the maximum width of glitch pulses on the SCL and SDA inputs that will be rejected. Units are 5 nanoseconds.



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x06	I2C Control 2	7	FORWARD CHANNEL SEQUENCE ERROR	R	0	Control Channel Sequence Error Detected This bit indicates a sequence error has been detected in forward control channel. If this bit is set, an error may have occurred in the control channel operation.
		6	CLEAR SEQUENCE ERROR	RW	0	Clears the Sequence Error Detect bit
		5	RESERVED	R	0	Reserved.
		4:3	SDA Output Delay	RW	0	SDA Output Delay This field configures output delay on the SDA output. Setting this value will increase output delay in units of 50ns. Nominal output delay values for SCL to SDA are: 00 : 250ns 01: 300ns 10: 350ns 11: 400ns
		2	LOCAL WRITE DISABLE	RW	0	Disable Remote Writes to Local Registers Setting this bit to a 1 will prevent remote writes to local device registers from across the control channel. This prevents writes to the Deserializer registers from an I2C master attached to the Serializer. Setting this bit does not affect remote access to I2C slaves at the Deserializer.
		1	I2C BUS TIMER SPEEDUP	RW	0	Speed up I2C Bus Watchdog Timer 1: Watchdog Timer expires after approximately 50 microseconds 0: Watchdog Timer expires after approximately 1 second.
		0	I2C BUS TIMER DISABLE	RW	0	Disable I2C Bus Watchdog Timer When the I2C Watchdog Timer may be used to detect when the I2C bus is free or hung up following an invalid termination of a transaction. If SDA is high and no signalling occurs for approximately 1 second, the I2C bus will assumed to be free. If SDA is low and no signaling occurs, the device will attempt to clear the bus by driving 9 clocks on SCL
0x07	REMOTE ID	7:1	REMOTE ID (Loaded from remote SER)	RW	0x00	7-bit Serializer Device ID Configures the I2C Slave ID of the remote Serializer. A value of 0 in this field disables I2C access to the remote Serializer. This field is automatically loaded from the Serializer once RX Lock has been detected. Software may overwrite this value, but should also assert the FREEZE DEVICE ID bit to prevent loading by the Bidirectional Control Channel.
		0	FREEZE DEVICE ID	RW	0	Freeze Serializer Device ID Prevent auto-loading of the Serializer Device ID from the Forward Channel. The ID will be frozen at the value written.
0x08	SlaveID[0]	7:1	SLAVE ID0	RW	0	7-bit Remote Slave Device ID 0 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID0, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.
		0	RESERVED	RW	0	Reserved.
0x09	SlaveID[1]	7:01	SLAVE ID1	RW	0	7-bit Remote Slave Device ID 1 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID1, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.
		0	RESERVED	RW	0	Reserved.



Table 12. Serial	Control Bus	Registers	(continued)	)

Average         Average         Configures the physical I2C address of the remote I2C Slave device attached to the Slave Alias ID2, the transaction across the Bidrectional Control Channel to the Serializer.           0x0B         SlaveID[3]         7:1         SLAVE ID3         RW         0         Reserved.           0x0B         SlaveID[4]         7:1         SLAVE ID3         RW         0         Reserved.           0x0C         SlaveID[4]         7:1         SLAVE ID3         RW         0         Reserved.           0x0C         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0x0C         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0x0C         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0x0C         SlaveID[5]         7:1         SLAVE ID4         RW         0         Reserved.           0x0D         RESERVED         RW         0         Reserved.         Configures the physical I2C address of the remote I2C Slave device attached to the remote Senilizer. If an I2C transaction is addressed to the Slave Alias IDA, the transaction will be remapped to this address before passing the transaction across the Bidrectional Control Channel to the Senilizer.           0x0DD         SlaveID[5]	ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
DAUB         SlaveID[3]         7.1         SLAVE ID3         RW         0         7-bit Remote Slave Device ID 3 Configures the physical I2C address of the remote I2C Slave device attached to the serie remote Serializer. If an I2C transaction at orss addressed to the Slave Alias ID1, the transaction at orss the Bidrectional Control Channel to the Serializer.           0         RESERVED         RW         0         Reserved.           0.00CC         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0.00CC         SlaveID[5]         7:1         SLAVE ID4         RW         0         Reserved.           0.00D         RESERVED         RW         0         Reserved.         Configures the physical I2C address of the remote I2C Slave device attached to the remote sensitizer. If an I2C transaction at orss the Bidrectional Control Channel to the Serializer.           0.00D         SlaveID[5]         7:1         SLAVE ID5         RW         0         Reserved.           0x0D         RESERVED         RW         0         Reserved.         Configures the physical I2C address of the remote I2C Slave device attached to the remote sensitizer. If an I2C transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transa	0x0A	SlaveID[2]	7:1	SLAVE ID2	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID2, the transaction will be remapped to this address before passing the transaction across
Note ID         Internet ID         Internet ID         Configures the physical IZC address of the remote IZC Slave device attached to the remote Serializer. If an IZC transaction is addressed to the Slave Alias ID3, the transaction will be remapped to this address before passing the transaction across the Bidrectional Control Channel to the Serializer.           0x0C         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0x0C         SlaveID[4]         7:1         SLAVE ID4         RW         0         Reserved.           0x0C         SlaveID[5]         7:1         SLAVE ID4         RW         0         Reserved.           0x0D         RESERVED         RW         0         Reserved.         Configures the physical IZC address of the remote IZC Slave device attached to the remote Serializer. If an IZC transaction is addressed to the Slave Alias ID4, the transaction across the Bidrectional Control Channel to the Serializer.           0x0D         SlaveID[5]         7:1         SLAVE ID5         RW         0         Reserved.           0x0D         Reserved.         0         Reserved.         Configures the physical IZC address of the remote IZC Slave device attached to the remote Serializer. If an IZC transaction is addressed to the Silve Alias ID5, the transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transaction will be remapped to this address before passing the transactin will be device attachet			0	RESERVED	RW	0	Reserved.
OxOC         SlaveID[4]         7:1         SLAVE ID4         RW         0         7-bit Remote Slave Device ID 4 Configures the physical IZC address of the remote IZC Slave device attached to the remote Save Derivation Will be remapped to this address before passing the transaction arross the Bidirectional Control Channel to the Serializer. If an IZC transaction arross the Bidirectional Control Channel to the Serializer.           0x0D         SlaveID[5]         7.1         SLAVE ID5         RW         0         Reserved.           0x0D         SlaveID[5]         7.1         SLAVE ID5         RW         0         Reserved.           0x0D         SlaveID[5]         7.1         SLAVE ID5         RW         0         Reserved.           0x0D         SlaveID[6]         7.1         SLAVE ID5         RW         0         Reserved.           0x0D         RESERVED         RW         0         Reserved.         Configures the physical U2c address of the remote I2C Slave device attached to the remote Save Device ID 6 Configures the Physical IZC address of the remote I2C Slave device attached to the remote Save Device ID 6           0x0DE         SlaveID[6]         7.1         SLAVE ID6         RW         0         Reserved.           0x0F         SlaveID[7]         7.1         SLAVE ID7         RW         0         Reserved.           0x0F         SlaveAlias[0]	0x0B	0x0B SlaveID[3]		SLAVE ID3	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID3, the transaction will be remapped to this address before passing the transaction across
And A         And A         And A         Configures the physical IZC address of the remote IZC Slave device attached to the remote Serializer. If an IZC transaction will be remapped to this address before passing the transaction across the Bidirectional Control Control Channel to the Serializer.           0x0D         SlaveID[5]         7:1         SLAVE ID5         RW         0         Reserved.           0x0D         SlaveID[6]         7:1         SLAVE ID5         RW         0         7-bit Remote Slave Device ID 5 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction sis addresses to the Slave Alias ID5, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.           0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         Reserved.           0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         Reserved.           0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         Reserved.           0x0F         SlaveID[6]         7:1         SLAVE ID7         RW         0         Reserved.           0x0F         SlaveID[7]         0         RESERVED         RW         0         Reserved.           0x0F         SlaveAlias[0]         7:1			0	RESERVED	RW	0	Reserved.
DAUD         SlaveID[5]         7:1         SLAVE IDS         RW         0         7-bit Remote Slave Device ID 5 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias IDS, the transaction across the Bidrectional Control Channel to the Serializer.           0         RESERVED         RW         0         Reserved.           0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         Reserved.           0         RESERVED         RW         0         Reserved.         Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID6, the transaction will be remapped to this address before passing the transaction will be remapped to the Slave Alias ID6. The transaction across the Bidrectional Control Channel to the Serializer.           0x0F         SlaveID[7]         7:1         SLAVE ID7         RW         0         7-bit Remote Slave Device ID 7 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction across the Bidrectional Control Channel to the Serializer.           0x0F         SlaveAlias[0]         7:1         SLAVE ID7         RW         0         7-bit Remote Slave Device ID 7 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction across the Bidrectional Control Channel to the Serializer.	0x0C	SlaveID[4]	7:1	SLAVE ID4	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID4, the transaction will be remapped to this address before passing the transaction across
Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID5, the transaction across the Bidirectional Control Channel to the Serializer.           0         RESERVED         RW         0         Reserved.           0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         Reserved.           0x0E         SlaveID[7]         7:1         SLAVE ID6         RW         0         Reserved.           0x0F         SlaveID[7]         7:1         SLAVE ID7         RW         0         Reserved.           0x0F         SlaveAlias[0]         7:1         SLAVE ALIAS         RW         0         Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID7, the transaction across the Bidrectio			0	RESERVED	RW	0	Reserved.
0x0E         SlaveID[6]         7:1         SLAVE ID6         RW         0         7-bit Remote Slave Device ID 6 Configures the physical I2C address of the remote I2C Slave device attached to the Slave Alias ID6, the transaction is addressed to the Slave Alias ID6, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.           0x0F         SlaveID[7]         7:1         SLAVE ID7         RW         0         Reserved.           0x10         RESERVED         RW         0         Reserved.         Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. In a I2C transaction is addressed to the Slave Davias ID7, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.           0x10         SlaveAlias[0]         7:1         SLAVE ALIAS ID0         RW         0         Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID1 re	0x0D	0x0D SlaveID[5]		SLAVE ID5	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID5, the transaction will be remapped to this address before passing the transaction across
No. 1         State Alias [1]         Configures the physical 12C address of the remote 12C Slave device attached to the remote Serializer. If an 12C transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.           0         RESERVED         RW         0         Reserved.           0x0F         SlaveID[7]         7:1         SLAVE ID7         RW         0         Reserved.           0x0F         SlaveID[7]         7:1         SLAVE ID7         RW         0         Configures the physical 12C address of the remote 12C Slave device attached to the remote Serializer. If an 12C transaction is addressed to the Slave Alias ID7, the transaction across the Bidirectional Control Channel to the Serializer.           0x10         SlaveAlias[0]         7:1         SLAVE ALIAS         RW         0         Reserved.           0x11         SlaveAlias[1]         7:1         SLAVE ALIAS         RW         0         Reserved.           0x11         SlaveAlias[1]         7:1         SLAVE ALIAS         RW         0         Reserved.           0x11         SlaveAlias[1]         7:1         SLAVE ALIAS         RW         0         Configures the decoder for detecting transactions designated for an 12C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID orgister. A value of 0 in this field disables accees to the			0	RESERVED	RW	0	Reserved.
OxOF         SlaveID[7]         7:1         SLAVE ID7         RW         0         7-bit Remote Slave Device ID 7 Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID7, the transaction will be remapped to this address before passing the transaction across the Bidirectional Control Channel to the Serializer.           0         RESERVED         RW         0         Reserved.           0x10         SlaveAlias[0]         7:1         SLAVE ALIAS ID0         RW         0         Reserved.           0         RESERVED         RW         0         Reserved.         0         Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remote Serializer. A value of 0 in this field disables access to the remote I2C Slave.           0         RESERVED         0         Reserved.           0x11         SlaveAlias[1]         7:1         SLAVE ALIAS ID1         RW         0         7-bit Remote Slave Device Alias ID 1 Configures the decoder for detecting transactions designated for an I2C Slave.           0x11         SlaveAlias[1]         7:1         SLAVE ALIAS ID1         RW         0         7-bit Remote Slave Device Alias ID 1 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID1 register. A v	0x0E	SlaveID[6]	7:1	SLAVE ID6	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID6, the transaction will be remapped to this address before passing the transaction across
Image: And the problem in the probl			0	RESERVED	RW	0	Reserved.
0x10       SlaveAlias[0]       7:1       SLAVE ALIAS ID0       RW       0       7-bit Remote Slave Device Alias ID 0 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID0 register. A value of 0 in this field disables access to the remote I2C Slave.         0       RESERVED       0       Reserved.         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS ID1       RW       0       7-bit Remote Slave Device Alias ID 1 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID1 register. A value of 0 in this field disables access to the remote I2C Slave.	0x0F	SlaveID[7]	7:1	SLAVE ID7	RW	0	Configures the physical I2C address of the remote I2C Slave device attached to the remote Serializer. If an I2C transaction is addressed to the Slave Alias ID7, the transaction will be remapped to this address before passing the transaction across
ID0       ID0       Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID0 register. A value of 0 in this field disables access to the remote I2C Slave.         0       RESERVED       0       Reserved.         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS ID1       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS ID1       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS       RW       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS       RW       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS       RW       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS       RW       0       0       7-bit Remote Slave Device Alias ID 1         0x11       SlaveAlias[1]       7:1       SLAVE ALIAS       RW       0       0       1         0x12       Slave ID1       register. A value of 0 in this field disables access to the remote I2C Slave.       1       1 <td></td> <td></td> <td>0</td> <td>RESERVED</td> <td>RW</td> <td>0</td> <td>Reserved.</td>			0	RESERVED	RW	0	Reserved.
0x11       SlaveAlias[1]       7:1       SLAVE ALIAS ID1         10x11       SlaveAlias[1]       7:1       SLAVE ALIAS ID1         10x1       ID1       ID1       0       7-bit Remote Slave Device Alias ID 1         10x1       ID1       ID1       0       7-bit Remote Slave Device Alias ID 1         10x1       ID1       ID1       0       7-bit Remote Slave Device Alias ID 1         10x1       ID1       ID1       ID1       0       7-bit Remote Slave Device Alias ID 1         10x1       ID1       ID1       ID1       ID1       0       7-bit Remote Slave Device Alias ID 1         10x1       ID1       ID1       ID1       ID1       ID1       ID1         10x1       ID1       ID1       ID1       ID1       ID1       ID1         10x1       ID1       ID1       ID1       ID1       ID1       ID1         10x1       ID1       ID1       ID1       ID1       ID1       ID1       ID1         10x1       ID1       ID1       ID1       ID1       ID1       ID1       ID1         10x1       ID1       ID1       ID1       ID1       ID1       ID1       ID1       ID1       ID1       <	0x10	SlaveAlias[0]	7:1		RW	0	Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID0 register. A value of 0 in this field disables access to
ID1       Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID1 register. A value of 0 in this field disables access to the remote I2C Slave.			0	RESERVED		0	Reserved.
0 RESERVED 0 Reserved.	0x11	SlaveAlias[1]	7:1		RW	0	Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID1 register. A value of 0 in this field disables access to
			0	RESERVED		0	Reserved.



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x12	SlaveAlias[2]	7:1	SLAVE ALIAS ID2	RW	0	7-bit Remote Slave Device Alias ID 2 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID2 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved.
0x13	SlaveAlias[3]	7:1	SLAVE ALIAS ID3	RW	0	7-bit Remote Slave Device Alias ID 3 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID3 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved.
0x14	SlaveAlias[4]	7:1	SLAVE ALIAS ID4	RW	0	7-bit Remote Slave Device Alias ID 4 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID4 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved.
0x15	SlaveAlias[5]	7:1	SLAVE ALIAS ID5	RW	0	7-bit Remote Slave Device Alias ID 5 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID5 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved
0x16	SlaveAlias[6]	7:1	SLAVE ALIAS ID6	RW	0	7-bit Remote Slave Device Alias ID 6 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID6 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved.
0x17	SlaveAlias[7]	7:1	SLAVE ALIAS ID7	RW	0	7-bit Remote Slave Device Alias ID 7 Configures the decoder for detecting transactions designated for an I2C Slave device attached to the remote Serializer. The transaction will be remapped to the address specified in the Slave ID7 register. A value of 0 in this field disables access to the remote I2C Slave.
		0	RESERVED		0	Reserved.
0x18	MAILBOX_ 18	7:0	MAILBOX_18	RW	0	Mailbox Register This register is an unused read/write register that can be used for any purpose such as passing messages between I2C masters on opposite ends of the link.
0x19	MAILBOX_ 19	7:0	MAILBOX_19	RW	0x01	Mailbox Register This register is an unused read/write register that can be used for any purpose such as passing messages between I2C masters on opposite ends of the link.



ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x1A	GPIO[9] and Global GPIO Config	7	GLOBAL GPIO OUTPUT VALUE	RW	0	Global GPIO Output Value This value is output on each GPIO pin when the individual pin is not otherwise enabled as a GPIO and the global GPIO direction is Output
		6	RESERVED	RW	0	Reserved
	5 GLOBAL GP FORCE DIR	GLOBAL GPIO FORCE DIR	RW	0	The GLOBAL GPIO DIR and GLOBAL GPIO EN bits configure the pad in input direction or output direction for functional mode	
		4	GLOBAL GPIO FORCE EN	RW	0 or GPIO mode. The GLOBAL bits are overridden individual GPIO DIR and GPIO EN bits. {GLOBAL GPIO DIR, GLOBAL GPIO EN} 00: Functional mode; output 10: Tri-state 01: Force mode; output 11: Force mode; input	individual GPIO DIR and GPIO EN bits. {GLOBAL GPIO DIR, GLOBAL GPIO EN} 00: Functional mode; output 10: Tri-state
		3	GPIO9 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	RESERVED	RW	0	Reserved
		1	GPIO9 DIR	RW	0	The GPIO DIR and GPIO EN bits configure the pad in input
		0	GPIO9 EN	RW	0	direction or output direction for functional mode or GPIO mode. {GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input
0x1B	Frequency Counter	7:0	Frequency Count	RW	0	Frequency Counter control A write to this register will enable a frequency counter to count the number of pixel clock during a specified time interval. The time interval is equal to the value written multiplied by the oscillator clock period (nominally 50ns). A read of the register returns the number of pixel clock edges seen during the enabled interval. The frequency counter will freeze at 0xff if it reaches the maximum value. The frequency counter will provide a rough estimate of the pixel clock period. If the pixel clock frequency is known, the frequency counter may be used to determine the actual oscillator clock frequency.
0x1C	General	7:5	RESERVED	R	0	Reserved.
	Status	4	DUAL_RX_STS	R	0	Receiver Dual Link Status: This bit indicates the current operating mode of the FPD-Link III Receive port 1: 2-lane mode active 0: 1-lane mode active
		3	I2S LOCKED	R	0	I2S LOCK STATUS 0: I2S PLL controller not locked 1: I2S PLL controller locked to input I2S clock
		2	RESERVED	R	0	Reserved.
		1	RESERVED	R	0/1	Reserved.
		0	LOCK	R	0	De-Serializer CDR, PLL's clock to recovered clock frequency 1: De-Serializer locked to recovered clock 0: De-Serializer not locked In Dual Link mode, this indicates both channels are locked.

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l able 12.	Serial	Control Bus	s Realsters	(continued)



Table 12	. Serial Cont	rol Bus Red	aisters (cont	inued)

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x1D	GPIO0 Config					GPIO0 and D_GPIO0 Configuration If PORT1_SEL is set, this register controls the D_GPIO0 pin
		7:4	Rev-ID	R		Revision ID
		3	GPIO0 OUTPUT VALUE D_GPIO0 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	GPIO0 REMOTE ENABLE D_GPIO0 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		1	GPIO0 DIR D_GPIO0 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input direction or output direction for functional mode or GPIO mode.
		0	GPIO0 EN D_GPIO0 EN	RW	0	{GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input
0x1E	GPIO1_2 Config					GPIO1/GPIO2 and D_GPIO1/D_GPIO2 Configuration If PORT1_SEL is set, this register controls the D_GPIO1 and D_GPIO2 pins
		7	GPIO2 OUTPUT VALUE D_GPIO2 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		6	GPIO2 REMOTE R' ENABLE D_GPIO2 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		5	GPIO2 DIR D_GPIO2 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input direction or output direction for functional mode or GPIO mode.
		4 GPIO2 EN RW 0 D_GPIO2 EN	0	{GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input		
		3	GPIO1 OUTPUT VALUE D_GPIO1 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	GPIO1 REMOTE ENABLE D_GPIO1 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		1	GPIO1 DIR D_GPIO1 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input direction or output direction for functional mode or GPIO mode.
		0	GPIO1 EN D_GPIO1 EN	RW	0	{GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input



ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x1F	GPIO3 Config					GPIO3 and D_GPIO3 Configuration If PORT1_SEL is set, this register controls the D_GPIO3 pin
		7:4	RESERVED	RW	0	Reserved (No GPIO 4)
		3	GPIO3 OUTPUT VALUE D_GPIO3 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	GPIO3 REMOTE ENABLE D_GPIO3 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		1	GPIO3 DIR D_GPIO3 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input direction or output direction for functional mode or GPIO mode.
		0	GPIO3 EN D_GPIO3 EN	RW	0	{GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input
0x20	GPIO5_6 Config	7	GPIO6 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		6	GPIO6 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		5	GPIO6 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input
		4	GPIO6 EN	RW	0	direction or output direction for functional mode or GPIO mode. {GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input
		3	GPIO5 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	GPIO5 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		1	GPIO5 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input
		0	GPIO5 EN	RW	0	direction or output direction for functional mode or GPIO mode. {GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x21	GPIO7_8 Config	7	GPIO8 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		6	GPIO8 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		5	GPIO8 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input
		4	GPIO8 EN	RW	0	direction or output direction for functional mode or GPIO mode. {GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input
		3	GPIO7 OUTPUT VALUE	RW	0	Local GPIO Output Value This value is output on the GPIO pin when the GPIO function is enabled, the local GPIO direction is Output, and remote GPIO control is disabled.
		2	GPIO7 REMOTE ENABLE	RW	0	Remote GPIO Control 1: Enable GPIO control from remote Serializer. The GPIO pin will be an output, and the value is received from the remote Serializer. 0: Disable GPIO control from remote Serializer.
		1	GPIO7 DIR	RW	0	The GPIO DIR and GPIO EN configures the pad in input
		0	GPIO7 EN	RW	0	direction or output direction for functional mode or GPIO mode. {GPIO DIR, GPIO EN} 00: Functional mode; output 10: Tri-state 01: GPIO mode; output 11: GPIO mode; input



# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x22	Datapath Control	7	OVERRIDE FC CONFIG	RW	0	<ol> <li>Disable loading of this register from the forward channel, keeping locally written values intact</li> <li>Allow forward channel loading of this register</li> </ol>
		6	PASS RGB (Loaded from remote SER)	RW	0	Setting this bit causes RGB data to be sent independent of DE. This allows operation in systems which may not use DE to frame video data or send other data when DE is deasserted. Note that this bit prevents HDCP operation and blocks packetized audio. This bit has no effect when paired with a serializer that does not support HDCP. 1: Pass RGB independent of DE 0: Normal operation Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.
		5	DE POLARITY (Loaded from remote SER)	RW	0	This bit indicates the polarity of the DE (Data Enable) signal. 1: DE is inverted (active low, idle high) 0: DE is positive (active high, idle low) Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.
			I2S_RPTR_REG EN (Loaded from remote SER)	RW	0	Regenerate I2S Data from Repeater I2S pins. 1: Don't output packetized audio data on RGB video output pins 0: Output packetized audio on RGB video output pins (Default). Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.
		3	I2S 4-CHANNEL ENABLE OVERRIDE (Loaded from remote SER)	RW	0	1: Set I2S 4-Channel Enable from bit of this register 0: Set I2S 4-Channel disabled Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.
		2	18-BIT VIDEO SELECT (Loaded from remote SER)	RW	0	1: Select 18-bit video mode 0: Select 24-bit video mode Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.
		1	I2S TRANSPORT SELECT (Loaded from remote SER)	RW	0	<ol> <li>Enable I2S In-Band Transport</li> <li>Enable I2S Data Island Transport</li> <li>Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.</li> </ol>
		0	I2S 4-CHANNEL ENABLE (Loaded from remote SER)	RW	0	<ul> <li>I2S 4-Channel Enable</li> <li>1: Enable I2S 4-Channel</li> <li>0: Disable I2S 4-Channel</li> <li>Note: this bit is automatically loaded from the remote serializer unless bit 7 of this register is set.</li> </ul>



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x23	RX Mode Status	7	RX RGB CHECKSUM	RW	0	RX RGB Checksum Enable Setting this bit enables the Receiver to validate a one-byte checksum following each video line. Checksum failures are reported in the HDCP_STS register.
		6	BC FREQ SELECT	RW	0	Back Channel Frequency Select 0: Divide-by-4 frequency based on the internal oscillator 1: Divide-by-2 frequency based on the internal oscillator This bit will be ignored if BC_HIGH_SPEED is set to a 1. Note that changing this setting will result in some errors on the back channel for a short period of time. If set over the control channel, the Serializer should first be programmed to Auto-Ack operation (Serializer register 0x03, bit 5) to avoid a control channel timeout due to lack of response from the Deserializer.
		5	AUTO_I2S	RW	1	Auto I2S Determine I2S mode from the AUX data codes.
		4	BC_HS_CTL	RW	Strap	Back-Channel High-Speed control Enables high-speed back-channel at 20Mbps. This bit will override the BC_FREQ_SELECT setting. Note that changing this setting will result in some errors on the back channel for a short period of time. If set over the control channel, the Serializer should first be programmed to Auto-Ack operation (Serializer register 0x03, bit 5) to avoid a control channel timeout due to lack of response from the Deserializer. BC_HIGH_SPEED is loaded from the MODE_SEL1 pin strap options.
		3	COAX_MODE	RW	Strap	Coax Mode Configures the FPD3 Receiver for operation over Coax or STP cabling: 0 : Shielded Twisted pair (STP) 1 : Coax Coax Mode is loaded from the MODE_SEL1 pin strap options.
		2	REPEATER_ MODE	RW	Strap	Repeater Mode Indicates device is strapped to repeater mode. Repeater Mode is loaded from the MODE_SEL1 pin strap options.
		1	RESERVED	RW	0	Reserved
		0	RESERVED	RW	0	Reserved



ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x24	BIST Control	7:6	BIST_OUT_ MODE	RW	0	BIST Output Mode 00 : No toggling 01 : Alternating 1/0 toggling 1x : Toggle based on BIST data
		5:4	AUTO_OSC_FR EQ	RW	0	When register 0x02 bit 5 (AUTO)CLOCK_EN) is set, this field controls the nominal frequency of the oscillator-based receive clock. 00: 50 MHz 01: 25 MHz 10: 10 MHz 11: Reserved
		3	BIST PIN CONFIG	RW	1	Bist Configured through Pin. 1: Bist configured through pin. 0: Bist configured through bits 2:0 in this register
		2:1	BIST CLOCK SOURCE	RW	0	BIST Clock Source This register field selects the BIST Clock Source at the Serializer. These register bits are automatically written to the CLOCK SOURCE bits (register offset 0x14) in the Serializer after BIST is enabled. See the appropriate Serializer register descriptions for details. 00: External Pixel Clock 01: Internal Pixel Clock 1x: Internal Pixel Clock
		0	BIST_EN	RW	0	BIST Control 1: Enabled 0: Disabled
0x25	BIST ERROR COUNT	7:0	BIST ERROR COUNT	R	0	Bist Error Count Returns BIST error count for selected port. Port selected is based on the PORT_SEL control in the DUAL_RX_CTL register 0x34 [1:0].
0x26	SCL High Time	7:0	SCL HIGH TIME	RW	0x83	I2C Master SCL High Time This field configures the high pulse width of the SCL output when the De-Serializer is the Master on the local I2C bus. Units are 50 ns for the nominal oscillator clock frequency. The default value is set to provide a minimum 5us SCL high time with the internal oscillator clock running at 26MHz rather than the nominal 20MHz.
0x27	SCL Low Time	7:0	SCL LOW TIME	RW	0x84	I2C SCL Low Time This field configures the low pulse width of the SCL output when the De-Serializer is the Master on the local I2C bus. This value is also used as the SDA setup time by the I2C Slave for providing data prior to releasing SCL during accesses over the Bidirectional Control Channel. Units are 50 ns for the nominal oscillator clock frequency. The default value is set to provide a minimum 5us SCL low time with the internal oscillator clock running at 26MHz rather than the nominal 20MHz.



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x28	Datapath Control 2	7	OVERRIDE FC CONFIG	RW	0	<ol> <li>Disable loading of this register from the forward channel, keeping locally witten values intact</li> <li>Allow forward channel loading of this register</li> </ol>
		6	RESERVED	RW	0	Reserved
		5	VIDEO_ DISABLED (Loaded from remote SER)	RW	0	Forward channel video disabled 0 : Normal operation 1 : Video is disabled, control channel is enabled This is a status bit only, indicating the forward channel is not sending active video. In this mode, the control channel and GPIO functions are enabled. Setting OVERRIDE_FC_CONFIG will prevent this bit from changing.
		4	DUAL_LINK (Loaded from remote SER)	R		1: Dual Link mode enabled 0: Single Link mode enabled This bit will always be loaded from forward channel and cannot be written locally. To force DUAL_LINK receive mode, use the RX_PORT_SEL register (address 0x34)
		3	ALTERNATE I2S ENABLE (Loaded from remote SER)	RW	0	1: Enable alternate I2S output on GPIO1 (word clock) and GPIO0 (data) 0: Normal Operation
		2	I2S DISABLED (Loaded from remote SER)	RW	0	1: I2S DISABLED 0: Normal Operation
		1	28BIT VIDEO (Loaded from remote SER)	RW	0	1: 28 bit Video enable. i.e. HS, VS, DE are present in forward channel. 0: Normal Operation
		0	I2S SURROUND (Loaded from remote SER)	RW	0	1: I2S Surround enabled 0: I2S Surround disabled
0x2B	I2S Control	7:4	RESERVED	RW	0	Reserved
		3	I2S FIFO OVERRUN STATUS	R	0	I2S FIFO Overrun Status
		2	I2S FIFO UNDERRUN STATUS	R	0	I2S FIFO Underrun Status
		1	I2S FIFO ERROR RESET	RW	0	I2S Fifo Error Reset 1: Clears FIFO Error
		0	I2S DATA FALLING EDGE	RW	0	<ul><li>I2S Clock Edge Select</li><li>1: I2S Data is strobed on the Rising Clock Edge.</li><li>0: I2S Data is strobed on the Falling Clock Edge.</li></ul>
0x2E	PCLK Test Mode	7	EXTERNAL PCLK	RW	0	Select pixel clock from BISTC input
		6:0	RESERVED	RW	0	Reserved



# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x34	DUAL_RX_	7	RESERVED	R	0	Reserved
	CTL	6	RX_LOCK_ MODE	RW	0	RX Lock Mode:         Determines operating conditions for indication of RX_LOCK and generation of video data.         0 : RX_LOCK asserted only when receiving active video (Forward channel VIDEO_DISABLED bit is 0)         1 : RX_LOCK asserted when device is linked to a Serializer even if active video is not being sent. This allows indication of valid link where Bidirectional Control Channel is enabled, but Deserializer is not receiving Audio/Video data.
		5	RAW_2ND_BC	RW	0	Enable Raw Secondary Back channel If this bit is set to a 1, the secondary back channel will operate in a raw mode, passing D_GPIO0 from the Deserializer to the Serializer, without any oversampling or filtering.
		4:3	FPD3 INPUT MODE	RW	0	<ul> <li>FPD-Link III Input Mode</li> <li>Determines operating mode of FPD-Link III Receive interface</li> <li>00: Auto-detect based on received data</li> <li>01: Forced Mode: 2-lane</li> <li>10: Forced Mode: 1-lane, primary input</li> <li>11: Forced Mode: 1-lane, secondary input</li> </ul>
		2	RESERVED	RW	0	Reserved
		1	PORT1_SEL	RW	0	Selects Port 1 for Register Access from primary I2C Address For writes, port1 registers and shared registers will both be written. For reads, port1 registers and shared registers will be read. This bit must be cleared to read port0 registers.
		0	PORT0_SEL	RW	1	Selects Port 0 for Register Access from primary I2C Address For writes, port0 registers and shared registers will both be written. For reads, port0 registers and shared registers will both be read. Note that if PORT1_SEL is also set, then port1 registers will be read.
0x35	AEQ TEST					AEQ Test register If PORT1_SEL is set, this register sets port1 AEQ controls
		7	RESERVED	RW	0	Reserved
		6	AEQ_RESTART	RW	0	Set high to restart AEQ adaptation from initial value. Method is write HIGH then write LOW - not self clearing. Adaption will be restarted on both ports.
		5	OVERRIDE_AEQ FLOOR	RW	0	Enable operation of SET_AEQ_FLOOR
		4	SET_AEQ_ FLOOR	RW	0	AEQ adaptation starts from a pre-set floor value rather than from zero - recommended for long cable situations
		3:0	RESERVED	RW	0x0	Reserved



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x37	MODE_SEL	7	MODE_SEL1 DONE	RW	0	MODE_SEL1 Done: 0: indicates the MODE_SEL1 decode has not been latched into the MODE_SEL1 status bits. 1: indicates the MODE_SEL1 decode has completed and latched into the MODE_SEL1 status bits.
		6:4	MODE_SEL1	RW	0	MODE_SEL1 Decode 3-bit decode from MODE_SEL1 pin, see MODE_SEL1 table first column "#" for mode selection: 000: CSI0 / 5 Mbps / STP (#1 on MODE_SEL1) 001: CSI0 / 5 Mbps / coax (#2 on MODE_SEL1) 010: CSI0 / 20 Mbps / STP (#3 on MODE_SEL1) 011: CSI0 / 20 Mbps / coax (#4 on MODE_SEL1) 100: CSI1 / 5 Mbps / coax (#4 on MODE_SEL1) 101: CSI1 / 5 Mbps / coax (#6 on MODE_SEL1) 101: CSI1 / 50 Mbps / STP (#7 on MODE_SEL1) 111: CSI1 / 20 Mbps / coax (#8 on MODE_SEL1) 111: CSI1 / 20 Mbps / coax (#8 on MODE_SEL1)
		3	MODE_SEL0 DONE	RW	0	MODE_SEL0 Done: 0: indicates the MODE_SEL0 decode has not been latched into the MODE_SEL0 status bits. 1: indicates the MODE_SEL0 decode has completed and latched into the MODE_SEL0 status bits.
		2:0	MODE_SEL0	RW	0	MODE_SEL0 Decode         3-bit decode from MODE_SEL0 pin, see MODE_SEL0 table         first column "#" for mode selection:         000: 4 data lanes, 1 CSI port active        Active CSI port determined by MODE_SEL1 CSI_SEL bit.
0x3A	I2S_DIVSEL	7	reg_ov_mdiv	RW	0x0	0: No override for MCLK divider 1: Override divider select for MCLK
		6:4	reg_mdiv	RW	0x0	Divide ratio select for VCO output (32*REF/M) 000: Divide by 32 (=REF/M) 001: Divide by 16 (=2*REF/M) 010: Divide by 8 (=4*REF/M) 011: Divide by 4 (=8*REF/M) 100: Reserved 101: Divide by 2 (=16*REF/M) 110: Reserved 111: Divide by 1 (32*REF/M)
		3	RESERVED	R	0x0	
		2	reg_ov_mselect	RW	0x0	0: Divide ratio of reference clock VCO selected by PLL-SM 1: Override divide ratio of clock to VCO
		1:0	reg_mselect	RW	0x0	Divide ratio select for VCO input (M) 00: Divide by 1 01: Divide by 2 10: Divide by 4 11: Divide by 8



# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x41	LINK ERROR	7:5	RESERVED	RW	0	Reserved
	ERROR COUNT	4	LINK ERROR COUNT ENABLE	RW	0	Enable serial link data integrity error count 1: Enable error count 0: DISABLE
		3:0	LINK ERROR COUNT	RW	0x3	Link error count threshold. Counter is pixel clock based. clk0, clk1 and DCA are monitored for link errors, if error count is enabled, deserializer loose lock once error count reaches threshold. If disabled deserilizer loose lock with one error.
0x43	HSCC_	7:5	RESERVED	RW	0	Reserved
	CONTROL	4	SPI_MISO_ MODE	RW	0	SPI MISO pin mode during Reverse SPI mode During Reverse SPI mode, SPI_MISO is typically an output signal. For bused SPI applications, it may be necessary to tri- state the SPI_MISO output if the device is not selected (SPI_SS = 0). 0 : Always enable SPI_MISO output driver 1 : Tri-state SPI_MISO output if SPI_SS is not asserted (low)
		3	SPI_CPOL	RW	0	SPI Clock Polarity Control 0 : SPI Data driven on Falling clock edge, sampled on Rising clock edge 1 : SPI Data driven on Rising clock edge, sampled on Falling clock edge
		2:0	HSCC_MODE	RW	0	High-Speed Control Channel Mode Enables high-speed modes for the secondary link back-channel, allowing higher speed signaling of GPIOs or SPI interface: These bits indicates the High Speed Control Channel mode of operation: 000: Normal frame, GPIO mode 001: High Speed GPIO mode, 1 GPIO 010: High Speed GPIO mode, 2 GPIOs 011: High Speed GPIO mode: 4 GPIOs 100: Reserved 101: Reserved 110: High Speed, Forward Channel SPI mode 111: High Speed, Reverse Channel SPI mode
0x44	ADAPTIVE EQ BYPASS					Adaptive Equalizer Bypass register If PORT1_SEL is set, this register sets port1 AEQ controls
		7:5	EQ STAGE 1 SELECT VALUE	RW	0x3	EQ select value[5:3] - Used if adaptive EQ is bypassed.
		4	RESERVED	RW	0	Reserved
		3:1	EQ STAGE 2 SELECT VALUE	RW	0	EQ select value [2:0] - Used if adaptive EQ is bypassed.
		0	ADAPTIVE EQ BYPASS	RW	0	1: Disable adaptive EQ 0: Enable adaptive EQ
0x45	ADAPTIVE EQ MIN MAX					Adaptive Equalizer Configuration If PORT1_SEL is set, this register sets port1 AEQ configuration
		7:4	RESERVED	RW	0x08	Reserved
		3:0	ADAPTIVE EQ FLOOR VALUE	RW		When AEQ floor is enabled by mode-sel pin or register (reg_35[5:4]) the starting setting is given by this register.



ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x52	CML OUTPUT CTL1	7	CML CHANNEL SELECT 1	RW	0	Selects between PORT0 and PORT1 to output onto CMLOUT±. 0: Recovered forward channel data from RIN0± is output on CMLOUT± 1: Recovered forward channel data from RIN1± is output on CMLOUT± CMLOUT driver must be enabled by setting 0x56[3] = 1. Note: This bit must match 0x57[2:1] setting for PORT0 or PORT1.
		6:0	RESERVED	RW	0	Reserved
0x56	CML	7:4	RESERVED	RW	0	Reserved
	OUTPUT ENABLE	3	CMLOUT ENABLE	RW	0	Enable CMLOUT± Loop-through Driver 0: Disabled (Default) 1: Enabled
		2:0	RESERVED	RW	0	Reserved
0x57	CML	7:3	RESERVED	RW	0	Reserved
C	OUTPUT CTL2	2:1	CML CHANNEL SELECT 2	RW	0	Selects between PORT0 and PORT1 to output onto CMLOUT±. 01: Recovered forward channel data from RIN0± is output on CMLOUT± 10: Recovered forward channel data from RIN1± is output on CMLOUT± CMLOUT driver must be enabled by setting 0x56[3] = 1. Note: This must match 0x52[7] setting for PORT0 or PORT1.
		0	RESERVED	RW	0	Reserved



# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x64	PGCTL	7:4	PATGEN_SEL	RW	1	Fixed Pattern Select This field selects the pattern to output when in Fixed Pattern Mode. Scaled patterns are evenly distributed across the horizontal or vertical active regions. This field is ignored when Auto-Scrolling Mode is enabled. The following table shows the color selections in non-inverted followed by inverted color mode: 0000: Reserved 0001: White/Black 0010: Black/White 0011: Red/Cyan 0100: Green/Magenta 0101: Blue/Yellow 0110: Horizontally Scaled Black to White/White to Black 0111: Horizontally Scaled Black to Red/White to Cyan 1000: Horizontally Scaled Black to Green/White to Magenta 1001: Horizontally Scaled Black to Blue/White to Yellow 1010: Vertically Scaled Black to Blue/White to Yellow 1010: Vertically Scaled Black to Red/White to Cyan 1100: Vertically Scaled Black to Blue/White to Yellow 1100: Vertically Scaled Black to Blue/White to Yellow 1101: Vertically Scaled Black to Blue/White to Yellow 1100: Vertically Scaled Black to Blue/White to Yellow 1101: Vertically Scaled Black to Blue/White to Yellow 1101: Vertically Scaled Black to Blue/White to Plack 1011: Vertically Scaled Black to Blue/White to Plack 1011: Vertically Scaled Black to Blue/White to Yellow 1110: Custom color (or its inversion) configured in PGRS, PGGS, PGBS registers 1111: Reserved See TI App Note AN-2198
		3	PATGEN_UNH	RW	0	Enables the UNH-IOL compliance test pattern: 0: Pattern type selected by PATGEN_SEL 1: Compliance test pattern is selected. Value of PATGEN_SEL is ignored.
		2	PATGEN_ COLOR	RW	0	Enable Color Bars Pattern 0: Color Bars disabled (default) 1: Color bars enabled Overides the selection from bits [7:4]
		1	PATGEN_ VCOM_REV	RW	0	Reverse the order of color bands in VCOM pattern 0: Color sequence from top left is (YCBR) (default) 1: Color sequence from top left is (RBCY)
		0	PATGEN_EN	RW	0	Pattern Generator Enable: 1: Enable Pattern Generator 0: Disable Pattern Generator



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x65	PGCFG	7:5	RESERVED	R	0	Reserved
		4	PATGEN_18B	RW	0	<ul> <li>18-bit Mode Select:</li> <li>1: Enable 18-bit color pattern generation. Scaled patterns will have 64 levels of brightness and the R, G, and B outputs use the six most significant color bits.</li> <li>0: Enable 24-bit pattern generation. Scaled patterns use 256 levels of brightness.</li> <li>This bit has no effect in external timing mode (PATGEN_TSEL = 0).</li> </ul>
		3	PATGEN_ EXTCLK	RW	0	<ul> <li>Select PCLK of Pattern generator</li> <li>1: Selects the external pixel clock when using internal timing.</li> <li>0: Selects the internal divided clock when using internal timing.</li> <li>This bit has no effect in external timing mode (PATGEN_TSEL = 0).</li> </ul>
		2	PATGEN_TSEL	RW	0	<ul> <li>Timing Select Control:</li> <li>1: The Pattern Generator creates its own video timing as configured in the Pattern Generator Total Frame Size, Active Frame Size, Horizontal Sync Width, Vertical Sync Width, Horizontal Back Porch, Vertical Back Porch, and Sync Configuration registers.</li> <li>0: the Pattern Generator uses external video timing from the pixel clock, Data Enable, Horizontal Sync, and Vertical Sync signals.</li> </ul>
		1	PATGEN_INV	RW	0	Enable Inverted Color Patterns: 1: Invert the color output. 0: Do not invert the color output.
		0	PATGEN_ ASCRL	RW	0	Auto-Scroll Enable: 1: The Pattern Generator will automatically move to the next enabled pattern after the number of frames specified in the Pattern Generator Frame Time (PGFT) register. 0: The Pattern Generator retains the current pattern.
0x66	PGIA	7:0	PATGEN_IA	RW	0	Indirect Address: This 8-bit field sets the indirect address for accesses to indirectly-mapped registers. It should be written prior to reading or writing the Pattern Generator Indirect Data register. See TI App Note AN-2198.
0x67	PGID	7:0	PATGEN_ID	RW	0	Indirect Data: When writing to indirect registers, this register contains the data to be written. When reading from indirect registers, this register contains the readback value. See TI App Note AN-2198.
0x68	PGDBG	7:4	RESERVED	RW	0	Reserved
		3	PATGEN_BIST_ EN	RW	0	Pattern Generator BIST Enable: Enables Pattern Generator in BIST mode. Pattern Generator will compare received video data with local generator pattern. Upstream device must be programmed to the same pattern.
		2:0	RESERVED	RW	0	Reserved
0x69	PGTSTDAT	7	PATGEN_BIST_ ERR	R	0	Pattern Generator BIST Error Flag During Pattern Generator BIST mode, this bit indicates if the BIST engine has detected errors. If the BIST Error Count (available in the Pattern Generator indirect registers) is non- zero, this flag will be set.
		6:0	RESERVED	R	0	



# **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x6A	CSICFG0	7:6	RESERVED	RW	00	Reserved
		5:4	LANE_CNT	RW	00	Setup number of data lanes for the CSI ports. 00/01: 4 data lanes 10: 2 data lanes
		3	ULPM	RW	0	When set, put the data lanes in ultra-low power mode (LP00) by sending out a LP signalling sequence.
		2	ULPS	RW	0	When set with ULPM, put the clock lane into ultra-low power mode. No effect if ULPM is not set.
		1	CONTS_CLK	RW	0	When set, keep the clock lane running (in HS mode) during line blank (DE=0) and frame black (VS not active)
		0	CSI_DIS	RW	0	When set, disable the CSI state machine. Function as a soft reset.
0x6B	CSICFG1	7:4	OFMT	RW	0000	Program the output CSI data formats 0000: RGB888 0001: RGB666 0010: RGB565 0011: YUV420 Legacy 0100: YUV420 0101: YUV422_8 0110: RAW8 0111: RAW10 1000: RAW12 1001: YUV420 (CSPS)
		3:2	IFMT	RW	00	Program the input data format in HDMI terminology 00: RGB444 01: YUV422 10: YUV444 11: RAW
		1	INV_VS	RW	0	When set, the VS received from the digital receiver will be inverted. Because the CSI logic works on active-high VS, this bit is typically set when the VS from the data source is active-low.
		0	INV_DE	RW	0	When set, the DE received from the digital receiver will be inverted. Because the CSI logive works on active-high DE, this bit is typically set when the DE from the data source is active- low.
0x6C	CSIIA	7:0	CSI_IA	RW	0	Indirect address port for accessing CSI registers. Refer to Table 13
0x6D	CSIID	7:0	CSI_ID	RW	0	Indirect data port for accessing CSI registers. Refer to Table 13
0x6E	GPI Pin	7	GPI7 Pin Status	R	0	GPI7/I2S_WC pin status
	Status 1	6	GPI6 Pin Status	R	0	GPI6/I2S_DA pin status
		5	GPI5 Pin Status	R	0	GPI5/I2S_DB pin status
		4	RESERVED	R	0	Reserved for future use
		3	GPI3 Pin Status	R	0	GPI3 / I2S_DD pin status
		2	GPI2 Pin Status	R	0	GPI2 / I2S_DC pin status
		1	GPI1 Pin Status	R	0	GPI1 pin status
		0	GPI0 Pin Status	R	0	GPI0 pin status
0x6F	GPI Pin	7:1	RESERVED	R	0	Reserved for future use
	6F GPI Pin Status 2		GPI8 Pin Status	R	0	GPI8/I2S_CLK pin status
0x80	RX_BKSV0	7:0	BKSV0	R	0	BKSV0: Value of byte0 of the Receiver KSV.
0x81	 RX_BKSV1	7:0	BKSV1	R	0	BKSV1: Value of byte1 of the Receiver KSV.
0x82	 RX_BKSV2	7:0	BKSV2	R	0	BKSV2: Value of byte2 of the Receiver KSV.



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0x83	RX_BKSV3	7:0	BKSV3	R	0	BKSV3: Value of byte3 of the Receiver KSV.
0x84	RX_BKSV4	7:0	BKSV4	R	0	BKSV4: Value of byte4 of the Receiver KSV.
0x90	TX_KSV0	7:0	TX_KSV0	R	0	TX_KSV0: Value of byte0 of the Transmitter KSV.
0x91	TX_KSV1	7:0	TX_KSV1	R	0	TX_KSV1: Value of byte1 of the Transmitter KSV.
0x92	TX_KSV2	7:0	TX_KSV2	R	0	TX_KSV2: Value of byte2 of the Transmitter KSV.
0x93	TX_KSV3	7:0	TX_KSV3	R	0	TX_KSV3: Value of byte3 of the Transmitter KSV.
0x94	TX_KSV4	7:0	TX_KSV4	R	0	TX_KSV4: Value of byte4 of the Transmitter KSV.
0xC0	HDCP_DBG	7	RESERVED	R	0	Reserved
		6	HDCP_I2C_TO_ DIS	R	0	HDCP I2C Timeout Disable: Setting this bit to a 1 will disable the bus timeout function in the HDCP I2C master. When enabled, the bus timeout function allows the I2C master to assume the bus is free if no signaling occurs for more than 1 second. Set via the HDCP_DBG register in the HDCP Transmitter.
		5:4	RESERVED	R	0	Reserved
		3	RGB_CHKSUM_ EN	R	0	Enable RGB video line checksum: Enables sending of ones-complement checksum for each 8-bit RGB data channel following end of each video data line. Set via the HDCP_DBG register in the HDCP Transmitter.
		2	FAST_LV	R	0	Fast Link Verification: HDCP periodically verifies that the HDCP Receiver is correctly synchronized. Setting this bit will increase the rate at which synchronization is verified. When set to a 1, Pj is computed every 2 frames and Ri is computed every 16 frames. When set to a 0, Pj is computed every 16 frames and Ri is computed every 128 frames. Set via the HDCP_DBG register in the HDCP Transmitter.
		1	TMR_SPEEDUP	R	0	Timer Speedup: Speed up HDCP authentication timers. Set via the HDCP_DBG register in the HDCP Transmitter.
		0	HDCP_I2C_ FAST	R	0	HDCP I2C Fast mode Enable: Setting this bit to a 1 will enable the HDCP I2C Master in the HDCP Receiver to operation with Fast mode timing. If set to a 0, the I2C Master will operation with Standard mode timing. Set via the HDCP_DBG register in the HDCP Transmitter.
0xC1	HDCP_DBG	7:2	RESERVED	RW	0	Reserved
	2	1	NO_DECRYPT	RW	0	No Decrypt: When set to a 1, the HDCP Receiver will output the encrypted data on the RGB pins. All other functions will work normally. This provides a simple way of showing that the link is encrypted.
		0	HDCP_EN_ MODE	RW	0	<ul> <li>HDCP Enable Mode:</li> <li>This bit controls whether the HDCP Repeater function will enable HDCP in attached HDCP Transmitters if it detects HDCP is already enabled.</li> <li>1 : Don't re-enable HDCP if already enabled.</li> <li>0 : Re-enable HDCP at start of authentication, even if HDCP Transmitter already has HDCP enabled.</li> </ul>



Table 12	. Serial Control	Bus Registers (	(continued)
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ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0xC4	HDCP_STS	7:2	RESERVED	R	0	Reserved
		1	RGB_CHKSUM_ ERR	R	0	RGB Checksum Error Detected: If RGB Checksum in enabled through the HDCP Transmitter HDCP_DBG register, this bit will indicate if a checksum error is detected. This register may be cleared by writing any value to this register
		0	AUTHED	R	0	HDCP Authenticated: Indicates the HDCP authentication has completed suc-cessfully. The controller may now send video data re-quiring content protection. This bit will be cleared if authentication is lost or if the controller restarts authen-tication.
0xC9	KSV_FIFO_ DATA	7:0	KSV_FIFO_ DATA	RW	0x00	KSV_FIFO_DATA: During External Repeater Control mode, the External HDCP controller writes KSV data to the KSV FIFO through this register. A byte written to this register location will write one byte of KSV data to the KSV FIFO at the location indicated by the KSV_FIFO_ADDR registers.
0xCA	KSV_FIFO_A DDR0	7:0	KSV_FIFO_ ADDR0	RW	0x00	KSV FIFO Address Register 0: This register contains the lower 8 bits of the KSF FIFO Address. This value should be set to 0 before writing the first byte of KSV data to the KSV FIFO. The KSV FIFO Address will automatically increment for each write to the KSV_FIFO_DATA register.
0xCB	KSV_FIFO_A DDR1	7:0	KSV_FIFO_ ADDR1	RW	0x00	KSV FIFO Address Register 1: This register contains the most significant bit of the KSF FIFO Address. This value should be set to 0 before writing the first byte of KSV data to the KSV FIFO. The KSV FIFO Address will automatically increment for each write to the KSV_FIFO_DATA register.
0xE0	RPTR_TX0					HDCP Repeater Transmit Port 0 Register
		7:1	PORT0_ADDR	R	0	Transmit Port 0 I2C Address Indicates the I2C address for the Repeater Transmit Port.
		0	PORT0_VALID	R	0	Transmit Port 0 Valid Indicates that the HDCP Repeater has a transmit port at the I2C Address identified by upper 7 bits of this register
0xE1	RPTR_TX1					HDCP Repeater Transmit Port 1 Register
		7:1	PORT1_ADDR	R	0	Transmit Port 1 I2C Address Indicates the I2C address for the Repeater Transmit Port.
		0	PORT1_VALID	R	0	Transmit Port 1 Valid Indicates that the HDCP Repeater has a transmit port at the I2C Address identified by upper 7 bits of this register
0xE2	RPTR_TX2					HDCP Repeater Transmit Port 2 Register
		7:1	PORT2_ADDR	R	0	Transmit Port 2 I2C Address Indicates the I2C address for the Repeater Transmit Port.
		0	PORT2_VALID	R	0	Transmit Port 2 Valid Indicates that the HDCP Repeater has a transmit port at the I2C Address identified by upper 7 bits of this register
0xE3	RPTR_TX3					HDCP Repeater Transmit Port 3 Register
		7:1	PORT3_ADDR	R	0	Transmit Port 3 I2C Address Indicates the I2C address for the Repeater Transmit Port.
		0	PORT3_VALID	R	0	Transmit Port 3 Valid Indicates that the HDCP Repeater has a transmit port at the I2C Address identified by upper 7 bits of this register
0xF0	HDCP_RX_ ID0	7:0	HDCP_RX_ID0	R	0x5F	HDCP_RX_ID0: First byte ID code, '_'



## **Register Maps (continued)**

ADD (hex)	Register Name	Bit(s)	Function	Туре	Default Value (hex)	Description
0xF1	HDCP_RX_ ID1	7:0	HDCP_RX_ID1	R	0x55	HDCP_RX_ID1: 2nd byte of ID code, 'U'
0xF2	HDCP_RX_ ID2	7:0	HDCP_RX_ID2	R	0x48	HDCP_RX_ID2: 3rd byte of ID code. Value will be either 'B' or 'H'. 'H' indicates an HDCP capable device.
0xF3	HDCP_RX_ ID3	7:0	HDCP_RX_ID3	R	0x39	HDCP_RX_ID3: 4th byte of ID code: '9'
0xF4	HDCP_RX_ ID4	7:0	HDCP_RX_ID4	R	0x34	HDCP_RX_ID4: 5th byte of ID code: '4'
0xF5	HDCP_RX_ ID5	7:0	HDCP_RX_ID5	R	0x30	HDCP_RX_ID5: 6th byte of ID code: '0'

### Table 12. Serial Control Bus Registers (continued)

### Table 13. CSI Indirect Register Table

Offset (hex)	Register Name	Bit(s)	Default Value (hex)	Function
0x09	RAW_ALIGN	7:5	0x00	Reserved
		4		Raw Align. 0: RAW Output onto LSB's of RGB Bus 1: RAW Output onto MSB's of RGB Bus
		3:0		Reserved
0x13	CSI_EN_PORT0	7	0	Register Control 0 = Disable 1 = Enable
		6	0	Reserved
		5:0	0x3F	0x00 = Disable CSI Port 0 0x3F = Enable CSI Port 0
0x14	CSI_EN_PORT1	7	0	Register Control 0 = Disable 1 = Enable
		6	0	Reserved
		5:0	0x00	0x00 = Disable CSI Port 1 0x3F = Enable CSI Port 1
0x16	CSIPASS	7:3	0x02	Reserved
		2		CSI_PASS to GPIO3. Configures GPIO3 to output the PASS signal when this bit is set HIGH.
		1		CSI_PASS to GPIO0. Configures GPIO0 to output the PASS signal when this bit is set HIGH. This is the default.
		0	-	CSI_PASS. This bit reflects the status of the PASS signal.
0x2E	CSI_VC_ID	7:6	0x00	CSI Virtual Channel identifier. 00: CSI-2 outputs with ID as virtual channel 0. 01: CSI-2 outputs with ID as virtual channel 1. 10: CSI-2 outputs with ID as virtual channel 2. 11: CSI-2 outputs with ID as virtual channel 3.
		5:0		Reserved

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### 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

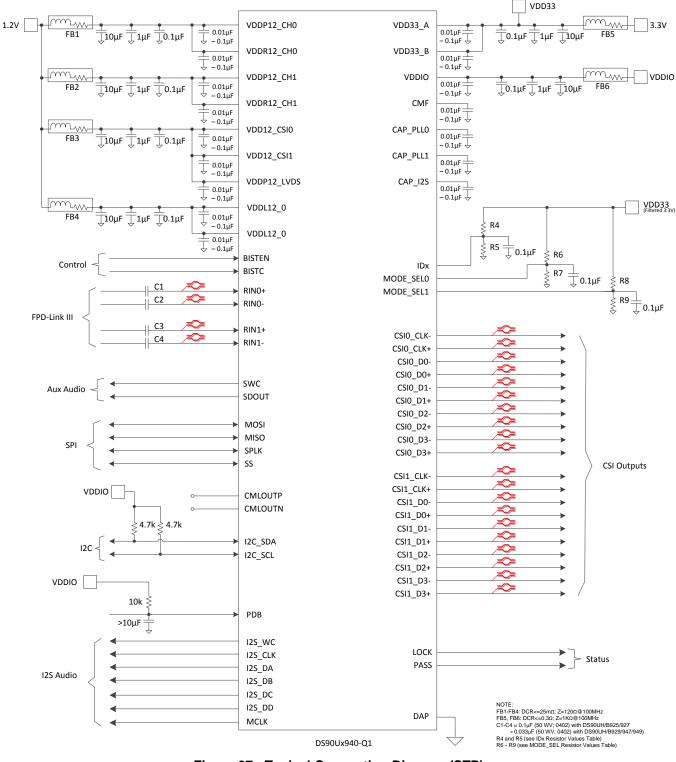
The DS90UH940-Q1 is a FPD-Link III Deserializer which, in conjunction with the DS90UH949/947-Q1 Serializers, converts 1-lane or 2-lane FPD-Link III streams into a MIPI CSI-2 interface. The Deserializer is capable of operating over cost-effective  $50\Omega$  single-ended coaxial or  $100\Omega$  differential shielded twisted-pair (STP) cables. It recovers the data from two FPD-Link III serial streams and translates it into a Camera Serial Interface (CSI-2) format compatible with MIPI DPHY/CSI-2 supporting video resolutions up to WUXGA and 1080p60 with 24-bit color depth.

### 9.2 Typical Applications

Bypass capacitors should be placed near the power supply pins. At a minimum, four (4)  $10\mu$ F capacitors should be used for local device bypassing. Ferrite beads are placed on the two sets of supply pins (VDD33 and VDDIO) for effective noise suppression. The interface to the graphics source is LVDS. The VDDIO pins may be connected to 3.3V or 1.8V. A capacitor and resistor are placed on the PDB pin to delay the enabling of the device until power is stable. See Figure 37 for a typical STP connection diagram and for a typical coax connection diagram.



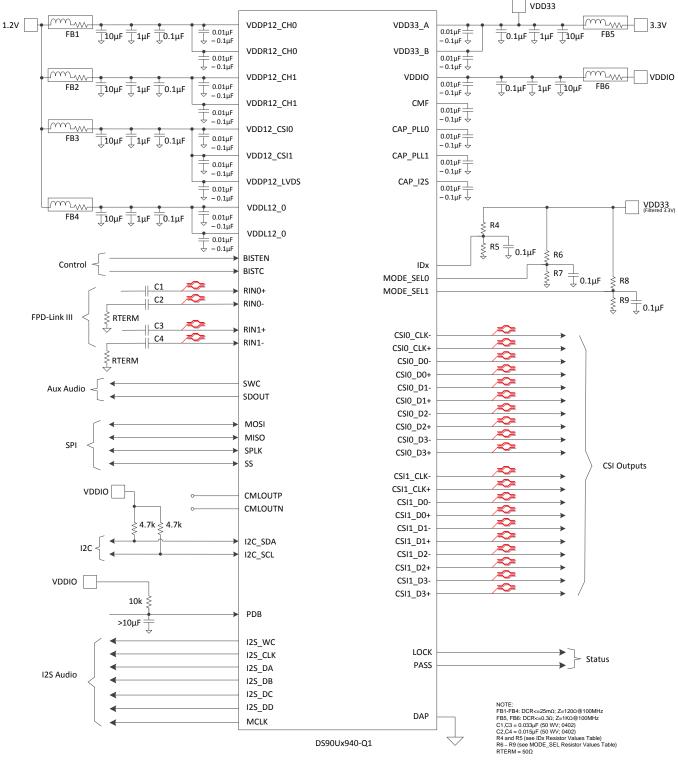
### **Typical Applications (continued)**

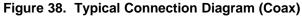






### **Typical Applications (continued)**

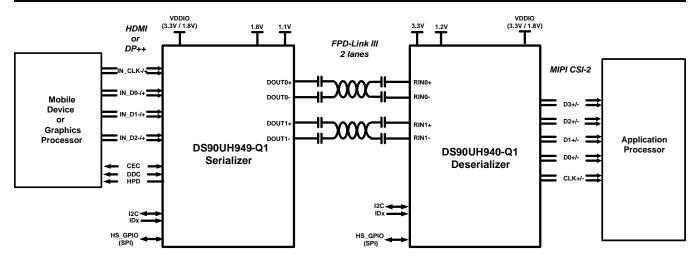






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### 9.2.1 Design Requirements

For the typical design application, use the following as input parameters.

#### **Table 14. Design Parameters**

Design Parameter	Example Value
VDDIO	1.8V or 3.3V
VDD12	1.2V
VDD33	3.3V
AC Coupling Capacitor for RIN0± and RIN1±	33 nF

The SER/DES supports only AC-coupled interconnects through an integrated DC-balanced decoding scheme. External AC coupling capacitors must be placed in series in the FPD-Link III signal path as illustrated in Figure 39. For applications utilizing single-ended 50  $\Omega$  coaxial cable, the unused data pins (RIN0-, RIN1-) should utilize a 15 nF capacitor and should be terminated with a 50  $\Omega$  resistor.

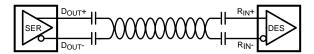


Figure 39. AC-Coupled Connection (STP)

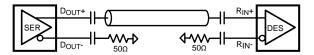


Figure 40. AC-Coupled Connection (Coaxial)

For high-speed FPD–Link III transmissions, the smallest available package should be used for the AC coupling capacitor. This will help minimize degradation of signal quality due to package parasitics. The I/O's require 33 nF AC coupling capacitors to the line.



#### 9.2.2 Detailed Design Procedure

#### 9.2.2.1 PCB Layout and Power System Considerations

Circuit board layout and stack-up for the LVDS serializer and deserializer devices should be designed to provide low-noise power to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mil) for power / ground sandwiches. This arrangement utilizes the plane capacitance for the PCB power system and has low-inductance, which has proven effectiveness especially at high frequencies, and makes the value and placement of external bypass capacitors less critical. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01  $\mu$ F to 10  $\mu$ F. Tantalum capacitors may be in the 2.2  $\mu$ F to 10  $\mu$ F range. The voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

MLCC surface mount capacitors are recommended due to their smaller parasitic properties. When using multiple capacitors per supply pin, locate the smaller value closer to the pin. A large bulk capacitor is recommended at the point of power entry. This is typically in the 50  $\mu$ F to 100  $\mu$ F range and will smooth low frequency switching noise. It is recommended to connect power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path. A small body size X7R chip capacitor, such as 0603 or 0805, is recommended for external bypass. A small body sized capacitor has less inductance. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20MHz-30MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Use at least a four layer board with a power and ground plane. Locate LVCMOS signals away from the LVDS lines to prevent coupling from the LVCMOS lines to the LVDS lines. Closely coupled differential lines of 100  $\Omega$  are typically recommended for LVDS interconnect. The closely coupled lines help to ensure that coupled noise will appear as common mode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

At least 32 thermal vias are necessary from the device center DAP to the ground plane. They connect the device ground to the PCB ground plane, as well as conduct heat from the exposed pad of the package to the PCB ground plane. More information on the WQFN style package, including PCB design and manufacturing requirements, is provided in TI Application Note: AN-1187.

#### 9.2.2.2 CML Interconnect Guidelines

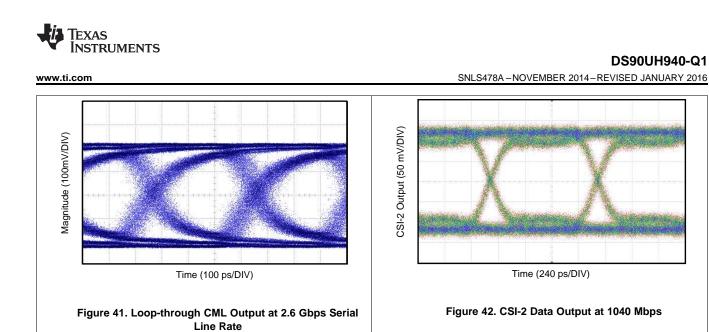
See AN-1108 and AN-905 for full details.

- Use  $100\Omega$  coupled differential pairs
- Use the S/2S/3S rule in spacings
  - S = space between the pair
  - 2S = space between pairs
  - 3S = space to LVCMOS signal
- Minimize the number of Vias
- Use differential connectors when operating above 500Mbps line speed
- Maintain balance of the traces
- · Minimize skew within the pair
- Terminate as close to the TX outputs and RX inputs as possible

Additional general guidance can be found in the LVDS Owner's Manual - available in PDF format from the Texas Instruments web site at: SNLA187

#### 9.2.3 Application Performance Plots

The plots below correspond to 1080p60 video application with 2-lane FPD-Link III input and MIPI 4 lanes output.



## **10** Power Supply Recommendations

This device provides separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description table provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter many be used to provide clean power to sensitive circuits such as PLLs.

### 10.1 Power Up Requirements and PDB Pin

When power is applied, power from the highest voltage rail to the lowest voltage rail on any of the supply pins. For 3.3V IO operation, VDDIO and VDD33 can be powered by the same supply and ramped simultaneously. The power supply ramp (VDD12, VDD33, and VDDIO) should be faster than 1.5ms with a monotonic rise. A large capacitor on the PDB pin is needed to ensure PDB arrives after all the supply pins have settled to the recommended operating voltage. When PDB pin is pulled up to VDD33, a 10 k $\Omega$  pull-up and a >10  $\mu$ F capacitor to GND are required to delay the PDB input signal rise. All inputs must not be driven until both VDD33 and VDDIO has reached steady state. Pins VDD33\_A and VDD33\_B should both be externally connected, bypassed, and driven to the same potential (they are not internally connected).

### 11 Layout

### 11.1 Layout Guidelines

Circuit board layout and stack-up for the FPD-Link III devices should be designed to provide low-noise power feed to the device. Good layout practice will also separate high frequency or high-level inputs and outputs to minimize unwanted stray noise pickup, feedback and interference. Power system performance may be greatly improved by using thin dielectrics (2 to 4 mils) for power/ground sandwiches. This arrangement provides plane capacitance for the PCB power system with low-inductance parasitics, which has proven especially effective at high frequencies, and makes the value and placement of external bypass capacitors less critical. External bypass capacitors should include both RF ceramic and tantalum electrolytic types. RF capacitors may use values in the range of 0.01  $\mu$ F to 0.1  $\mu$ F. Tantalum capacitors may be in the 2.2  $\mu$ F to 10  $\mu$ F range. Voltage rating of the tantalum capacitors should be at least 5X the power supply voltage being used.

Surface mount capacitors are recommended due to their smaller parasitics. When using multiple capacitors per supply pin, locate the smaller value closer to the pin. A large bulk capacitor is recommend at the point of power entry. This is typically in the 50  $\mu$ F to 100  $\mu$ F range and will smooth low frequency switching noise. It is recommended to connect power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane with via on both ends of the capacitor. Connecting power or ground pins to an external bypass capacitor will increase the inductance of the path.

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#### Layout Guidelines (continued)

A small body size X7R chip capacitor, such as 0603 or 0402, is recommended for external bypass. Its small body size reduces the parasitic inductance of the capacitor. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20MHz to 30 MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter may be used to provide clean power to sensitive circuits such as PLLs.

Use at least a four layer board with a power and ground plane. Locate LVCMOS signals away from the CML lines to prevent coupling from the LVCMOS lines to the CML lines. Closely-coupled differential lines of 100  $\Omega$  are typically recommended for CML interconnect. The closely coupled lines help to ensure that coupled noise will appear as common-mode and thus is rejected by the receivers. The tightly coupled lines will also radiate less.

Information on the WQFN style package is provided in TI Application Note: AN-1187.



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### 11.2 Layout Example

Stencil parameters such as aperture area ratio and the fabrication process have a significant impact on paste deposition. Inspection of the stencil prior to placement of the WQFN package is highly recommended to improve board assembly yields. If the via and aperture openings are not carefully monitored, the solder may flow unevenly through the DAP. Stencil parameters for aperture opening and via locations are shown in Figure 43:

							,		
Device	Pin Count	Mkt Dwg	PCB I/O Pad Size (mm)	PCB Pitch (mm)	PCB DAP Size(mm)	Stencil I/O Aperture (mm)	Stencil DAP Aperture (mm)	Number OF DAP Aperture Openings	Gap between DAP Aperture (Dim A mm)
DS90UH940-Q1	64	NKD	0.25 x 0.6	0.5	7.2 x 7.2	0.25 x 0.6	1.16 x 1.16	25	0.2



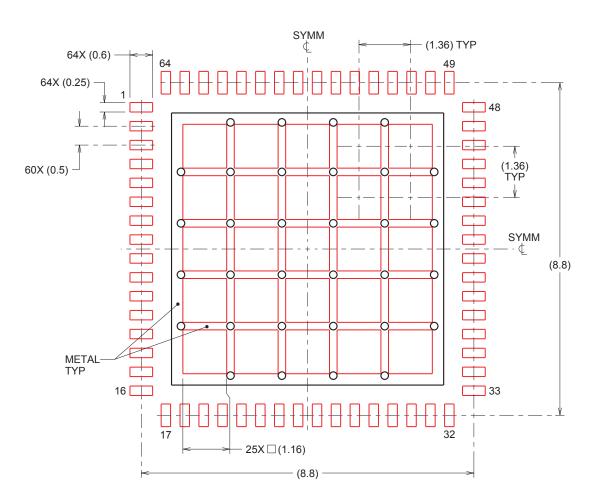


Figure 43. 64-Pin WQFN Stencil Example of Via and Opening Placement (dimensions in mm)



Figure 44 (PCB layout example) is derived from a layout design of the DS90UH940-Q1. This graphic and additional layout description are used to demonstrate both proper routing and proper solder techniques when designing in the Deserializer.

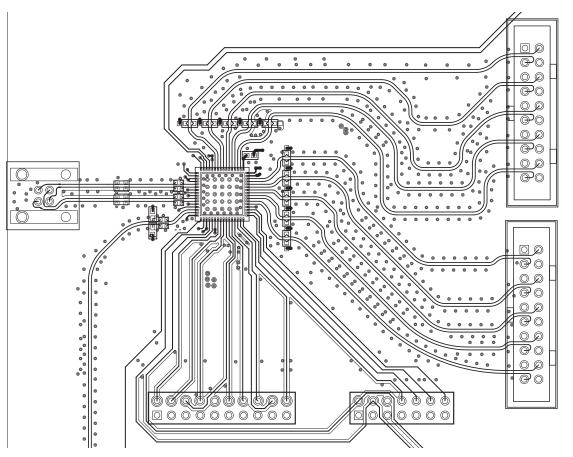


Figure 44. DS90UH940-Q1 Deserializer Example Layout

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## **12 Device and Documentation Support**

### **12.1 Documentation Support**

### 12.1.1 Related Documentation

For related documentation see the following:

- Soldering Specifications Application Report, SNOA549
- IC Package Thermal Metrics Application Report, SPRA953
- Channel-Link PCB and Interconnect Design-In Guidelines, SNLA008
- Transmission Line RAPIDESIGNER Operation and Application Guide, SNLA035
- Leadless Leadframe Package (LLP) Application Report, SNOA401
- LVDS Owner's Manual, SNLA187
- I2C Communication Over FPD-Link III with Bidirectional Control Channel, SNLA131
- Using the I2S Audio Interface of DS90Ux92x FPD-Link III Devices, SNLA221
- Exploring the Internal Test Pattern Generation Feature of 720p FPD-Link III Devices, SNLA132

### 12.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community TI's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support TI's Design Support** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.3 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

### 12.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.5 Glossary

#### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



6-Feb-2020

## PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DS90UH940TNKDRQ1	ACTIVE	WQFN	NKD	64	2000	Green (RoHS & no Sb/Br)	SN	Level-3-260C-168 HR	-40 to 105	90UH940Q1	Samples
DS90UH940TNKDTQ1	ACTIVE	WQFN	NKD	64	250	Green (RoHS & no Sb/Br)	SN	Level-3-260C-168 HR	-40 to 105	90UH940Q1	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

6-Feb-2020

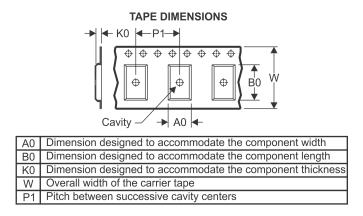
# PACKAGE MATERIALS INFORMATION

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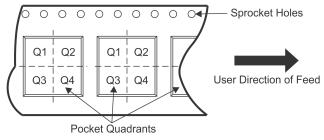
Texas Instruments

## TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS90UH940TNKDRQ1	WQFN	NKD	64	2000	330.0	16.4	9.3	9.3	1.3	12.0	16.0	Q1
DS90UH940TNKDTQ1	WQFN	NKD	64	250	178.0	16.4	9.3	9.3	1.3	12.0	16.0	Q1

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

9-Nov-2016



\*All dimensions are nominal

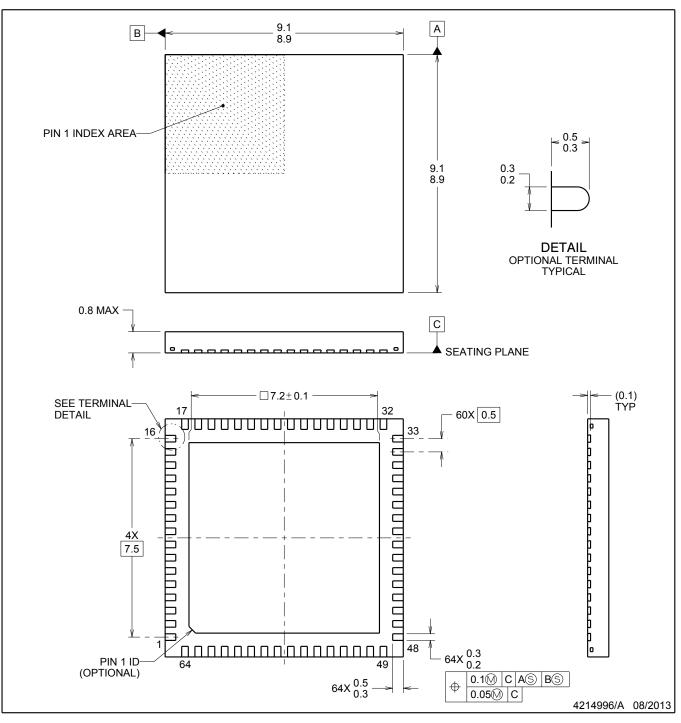
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DS90UH940TNKDRQ1	WQFN	NKD	64	2000	367.0	367.0	38.0
DS90UH940TNKDTQ1	WQFN	NKD	64	250	210.0	185.0	35.0

# PACKAGE OUTLINE



## WQFN - 0.8 mm max height

WQFN



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.

3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



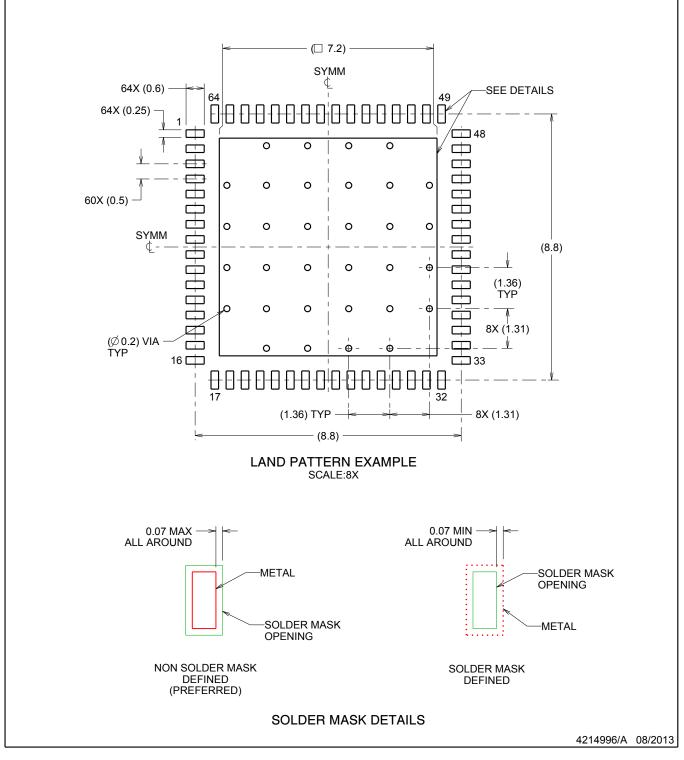
# **NKD0064A**

# NKD0064A

# EXAMPLE BOARD LAYOUT

## WQFN - 0.8 mm max height

WQFN



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, refer to QFN/SON PCB application note in literature No. SLUA271 (www.ti.com/lit/slua271).

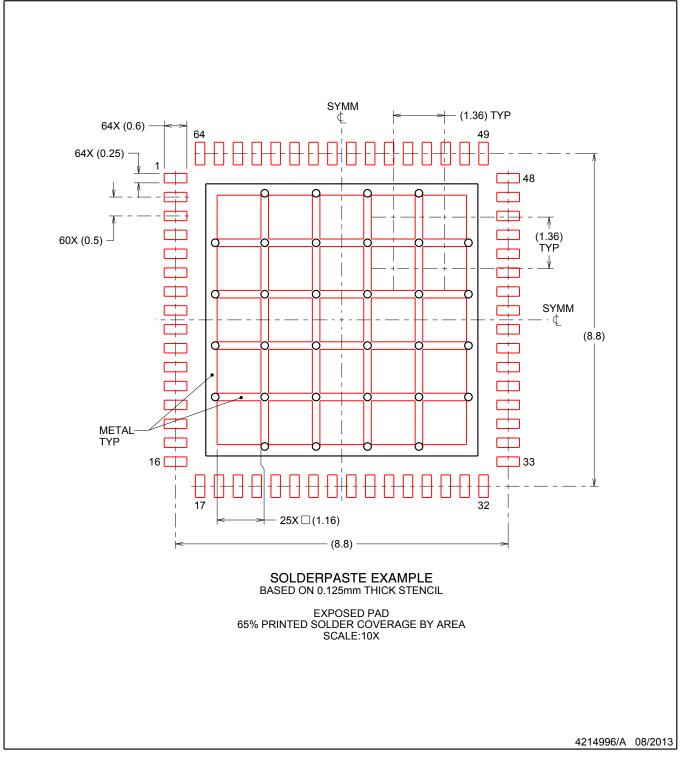


# **NKD0064A**

# EXAMPLE STENCIL DESIGN

## WQFN - 0.8 mm max height

WQFN



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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